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MODEL: WAFER-8522

3.5" SBC with ULV Intel® Celeron® M Processor VGA/LVDS/TTL, Dual GbE, USB 2.0 and Audio Fanless Design, Low Power Consumption

User Manual

TODOTT



Rev. 1.0 March 2007



Revision

MODEL	WAFER-8522 Intel [®] Celeron [®] M Motherboard Description Date of Issue		WAFER-8522 Intel [®] Celeron [®] M Motherboard	
Revision Number				
1.0	Initial release	March 2007		





Page iii

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If any of the components listed in the checklist below are missing, please do not proceed with the installation. Contact the IEI reseller or vendor you purchased the WAFER-8522 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to sales@iei.com.tw.

The items listed below should all be included in the WAFER-8522 package.

- 1 x WAFER-8522 single board computer
- 1 x Enclosure heat sink
- 1 x Audio cable
- 1 x IDE flat cable 44p/44p
- 1 x PS2 keyboard/mouse cable
- 1 x 4 COM port RS-232 cable
- 1 x Mini jumper pack
- 1 x Quick installation guide
- 1 x Utility CD

Images of the above items are shown in Chapter 3.



Table of Contents

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1	INTRODUCTION	
	1.1 WAFER-8522 Overview	4
	1.1.1 WAFER-8522 Board Variations	
	1.1.2 WAFER-8522 Applications	
	1.1.3 WAFER-8522 Benefits	4
	1.1.4 WAFER-8522 Features	5
	1.2 WAFER-8522 BOARD OVERVIEW	6
	1.2.1 WAFER-8522 Connectors	7
	1.2.2 Technical Specifications	8
2	DETAILED SPECIFICATIONS	11
	2.1 Overview	
	2.2 DIMENSIONS	
	2.2.1 Board Dimensions	
	2.2.2 External Interface Panel Dimensions	
	2.2.3 Enclosure Heat Sink Dimensions	
	2.3 Data Flow	15
	2.4 Compatible Processor	16
	2.4.1 CPU Overview	
	2.4.2 Intel [®] Celeron [®] M	
	2.5 INTEL [®] 855GME CHIPSET GRAPHICS MEMORY CONTROLLER HUB	16
	2.5.1 Intel [®] 852GM Overview	
	2.5.2 Intel [®] 852GM Memory Support	17
	2.5.3 Intel [®] 852GM Internal Graphics Controller	
	2.6 INTEL [®] 82801DB I/O CONTROLLER HUB (ICH4)	19
	2.6.1 Intel [®] ICH4 Overview	
	2.6.2 Intel [®] ICH4 IDE Interface	
	2.6.3 Intel [®] ICH4 Compact Flash Interface	
	2.6.4 Intel [®] ICH4 Audio Codec 97 (AC'97) Controller	
	2.6.5 Intel [®] ICH4 USB Controller	
	2.6.6 Intel [®] ICH4 PCI Interface	

Page v

3 8.

2.6.7 Intel [®] ICH4 Low Pin Count (LPC) Interface	22
2.6.8 BIOS	22
2.7 PCI BUS COMPONENTS	
2.7.1 PCI Bus Overview	22
2.7.2 GbE Ethernet	
2.7.3 PCI-104 Slot	
2.8 LPC BUS COMPONENTS	
2.8.1 LPC Bus Overview	
2.8.2 BIOS Chipset	
2.8.3 Super I/O Chipset	
2.8.3.1 Super I/O 16C550 UARTs	
2.8.3.2 Super I/O Keyboard Controller	
2.9 TPM MODULE	
2.10 Environmental and Power Specifications	
2.10.1 System Monitoring	
2.10.2 Operating Temperature and Temperature Control	
2.10.3 Power Consumption	27
3 UNPACKING	29
3 UNPACKING	 29
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 	
 3 UNPACKING	
 3 UNPACKING	
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 3.2.1 Unpacking Precautions 3.3 UNPACKING CHECKLIST 3.3.1 Package Contents 	
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 3.2 UNPACKING 3.2.1 Unpacking Precautions 3.3 UNPACKING CHECKLIST 3.3.1 Package Contents 4 CONNECTOR PINOUTS 	
 3 UNPACKING	
 3 UNPACKING	
 3 UNPACKING	
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 3.2.1 Unpacking Precautions 3.3 UNPACKING CHECKLIST 3.3.1 Package Contents 4 CONNECTOR PINOUTS 4.1 PERIPHERAL INTERFACE CONNECTORS 4.1.1 WAFER-8522 Layout 4.1.2 Peripheral Interface Connectors 4.1.3 External Interface Panel Connectors 	
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 3.2 UNPACKING Precautions 3.3 UNPACKING CHECKLIST 3.3 UNPACKING CHECKLIST 3.3 I Package Contents 4 CONNECTOR PINOUTS 4 CONNECTOR PINOUTS 4.1 PERIPHERAL INTERFACE CONNECTORS 4.1.1 WAFER-8522 Layout 4.1.2 Peripheral Interface Connectors 4.1.3 External Interface Panel Connectors 4.2 INTERNAL PERIPHERAL CONNECTORS 	
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 3.2 UNPACKING Precautions 3.3 UNPACKING CHECKLIST 3.3 UNPACKING CHECKLIST 3.3 I Package Contents 4 CONNECTOR PINOUTS 4 CONNECTOR PINOUTS 4.1 PERIPHERAL INTERFACE CONNECTORS 4.1.1 WAFER-8522 Layout 4.1.2 Peripheral Interface Connectors 4.1.3 External Interface Panel Connectors 4.2 INTERNAL PERIPHERAL CONNECTORS 4.2.1 AT Power Connector 	
 3 UNPACKING	
 3 UNPACKING 3.1 ANTI-STATIC PRECAUTIONS 3.2 UNPACKING 3.2 UNPACKING 3.2 UNPACKING Precautions 3.3 UNPACKING CHECKLIST 3.3 UNPACKING CHECKLIST 3.3.1 Package Contents 4 CONNECTOR PINOUTS 4.1 Peripheral INTERFACE CONNECTORS 4.1.1 WAFER-8522 Layout 4.1.2 Peripheral Interface Connectors 4.1.3 External Interface Panel Connectors 4.2 INTERNAL PERIPHERAL CONNECTORS 4.2.1 AT Power Connector 4.2.2 ATX Power Connector 4.2.3 Audio Connector 	

®Technology Corp.

	4.2.5 IDE Connector	40
	4.2.6 Inverter Power Connector	42
	4.2.7 Keyboard/Mouse Connector	43
	4.2.8 LED Connector	44
	4.2.9 PCI-104 Slot	45
	4.2.10 Power Button Connector	49
	4.2.11 Reset Button Connector	49
	4.2.12 Serial Port Connector (RS-232/422/485)	50
	4.2.13 Serial Port Connector (COM 3, COM 4, COM 5 and COM 6)	51
	4.2.14 TFT LCD LVDS Connector	53
	4.2.15 Internal USB Connectors	54
	4.3 EXTERNAL PERIPHERAL INTERFACE CONNECTORS	55
	4.3.1 External Peripheral Interface Connector Overview	55
	4.3.2 RJ-45 Ethernet Connector	56
	4.3.3 Serial Port Connector (COM1)	57
	4.3.4 USB Combo Ports	58
	4.3.5 VGA Connector	58
5	INSTALLATION	61
5	5.1 Anti-static Precautions	 61 62
5	INSTALLATION 5.1 Anti-static Precautions 5.2 Installation Considerations	 61 62 63
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices	61 62 63 63
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Checklist	61 62 63 63 64
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Notices 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION	61 62 63 63 64 65
5	 INSTALLATION	61 62 63 63 64 65 65
5	 INSTALLATION	61 62 63 63 64 65 65 66
5	 INSTALLATION	61 62 63 63 65 65 66 67
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Checklist 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION 5.3.1 SO-DIMM Installation 5.3.2 CF Card Installation 5.3.3 Mounting the WAFER-8522 Embedded Module 5.4 JUMPER SETTINGS	61 62 63 63 65 65 65 66 67 69
5	 INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Checklist 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION 5.3.1 SO-DIMM Installation 5.3.2 CF Card Installation 5.3.3 Mounting the WAFER-8522 Embedded Module 5.4 JUMPER SETTINGS 5.4.1 CF Card Setup Jumper Settings 	61 62 63 63 63 65 65 65 67 67 69 70
5	 INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Checklist 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION 5.3.1 SO-DIMM Installation 5.3.2 CF Card Installation 5.3.3 Mounting the WAFER-8522 Embedded Module 5.4 JUMPER SETTINGS 5.4.1 CF Card Setup Jumper Settings 5.4.2 Clear CMOS Jumper. 	61 62 63 63 64 65 65 66 67 69 70 71
5	 INSTALLATION	61 62 63 63 65 65 65 66 67 69 70 71 72
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Checklist 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION 5.3.1 SO-DIMM Installation 5.3.2 CF Card Installation 5.3.3 Mounting the WAFER-8522 Embedded Module 5.4 JUMPER SETTINGS 5.4.1 CF Card Setup Jumper Settings 5.4.2 Clear CMOS Jumper 5.4.3 COM Port Setting Jumper 5.4.4 LCD Voltage Selection	61 62 63 63 65 65 65 66 67 70 71 72 73
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Checklist 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION 5.3.1 SO-DIMM Installation 5.3.2 CF Card Installation 5.3.3 Mounting the WAFER-8522 Embedded Module 5.4 JUMPER SETTINGS 5.4.1 CF Card Setup Jumper Settings 5.4.2 Clear CMOS Jumper 5.4.3 COM Port Setting Jumper 5.4.4 LCD Voltage Selection 5.4.5 LCD Resolution Selection	61 62 63 63 65 65 65 65 67 70 71 72 73 74
5	INSTALLATION 5.1 ANTI-STATIC PRECAUTIONS 5.2 INSTALLATION CONSIDERATIONS 5.2.1 Installation Notices 5.2.2 Installation Notices 5.3 SO-DIMM MODULE INSTALLATION AND CF CARD INSTALLATION 5.3.1 SO-DIMM Installation 5.3.2 CF Card Installation 5.3.3 Mounting the WAFER-8522 Embedded Module 5.4 JUMPER SETTINGS 5.4.1 CF Card Setup Jumper Settings 5.4.2 Clear CMOS Jumper 5.4.3 COM Port Setting Jumper 5.4.5 LCD Resolution Selection 5.5 CHASSIS INSTALLATION	61 62 63 63 64 65 65 65 67 67 70 71 72 73 74 76



3 å.

®Technology Corp.

C Tech	nnology Corp.	
	5.5.2 Motherboar	d Installation

	5.5.2 Motherboard Installation	. 76
	5.6 INTERNAL PERIPHERAL DEVICE CONNECTIONS	. 76
	5.6.1 Peripheral Device Cables	. 76
	5.6.2 ATA Flat Cable Connection	. 77
	5.6.3 Audio Kit Installation	. 78
	5.6.4 Keyboard/Mouse Y-cable Connector	. 79
	5.6.5 Four Serial Port Connector Cable	. 80
	5.7 EXTERNAL PERIPHERAL INTERFACE CONNECTION	. 81
6	AMI BIOS	. 83
	6.1 INTRODUCTION	. 84
	6.1.1 Starting Setup	. 84
	6.1.2 Using Setup	. 84
	6.1.3 Getting Help	. 85
	6.1.4 Unable to Reboot After Configuration Changes	. 85
	6.1.5 BIOS Menu Bar	. 85
	6.2 MAIN	. 86
	6.3 Advanced	. 87
	6.3.1 CPU Configuration	. 88
	6.3.2 IDE Configuration	. 90
	6.3.2.1 IDE Master, IDE Slave	. 93
	6.3.3 Super IO Configuration	. 97
	6.3.4 Hardware Health Configuration	104
	6.3.5 MPS Configuration	105
	6.3.6 Trusted Computing	106
	6.3.7 USB Configuration	106
	6.3.7.1 USB Mass Storage Device Configuration	109
	6.4 Воот	110
	6.4.1 Boot Settings Configuration	111
	6.4.2 Boot Device Priority	113
	6.4.3 Removable Drives	114
	6.5 Security	115
	6.6 CHIPSET	117
	6.6.1 NorthBridge Configuration	117
	6.6.2 SouthBridge Configuration	123

	6.7 POWER KEY	124
	6.8 Exit	126
7	SOFTWARE DRIVERS	129
	7.1 Available Software Drivers	130
	7.2 CHIPSET DRIVER INSTALLATION	130
	7.3 REALTEK AUDIO DRIVER INSTALLATION	133
	7.4 INTEL GRAPHICS MEDIA ACCELERATOR DRIVER	136
	7.5 LAN DRIVER INSTALLATION	138
A	BIOS OPTIONS	141
B	WATCHDOG TIMER	145
C	ADDRESS MAPPING	149
	C.1 Address Map	150
	C.2 1ST MB MEMORY ADDRESS MAP	150
	C.3 IRQ MAPPING TABLE	151
	C.4 DMA CHANNEL ASSIGNMENTS	151
D	EXTERNAL AC'97 AUDIO CODEC	153
	D.1 INTRODUCTION	154
	D.1.1 Accessing the AC'97 CODEC	154
	D.1.2 Driver Installation	154
	D.2 SOUND EFFECT CONFIGURATION	154
	D.2.1 Accessing the Sound Effects Manager	154
	D.2.2 Sound Effect Manager Configuration Options	156
I	NDEX	159



Page ix

3 8.

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List of Figures

Figure 1-1: WAFER-8522 Overview	6
Figure 1-2: WAFER-8522 Solder Side Overview	6
Figure 2-1: WAFER-8522 Dimensions (mm)	12
Figure 2-2: External Interface Panel Dimensions (mm)	13
Figure 2-3: Enclosure Heat Sink Dimensions (mm)	14
Figure 2-4: Data Flow Block Diagram	15
Figure 4-1: Connector and Jumper Locations	34
Figure 4-2: AT Power Connector Location	36
Figure 4-3: ATX Power Connector Location	37
Figure 4-4: Audio Connector Pinouts	38
Figure 4-5: CF Card Socket Location	39
Figure 4-6: IDE Device Connector Location	41
Figure 4-7: Inverter Connector Location	43
Figure 4-8: Keyboard/Mouse Connector Location	44
Figure 4-9: LED Connector Locations	45
Figure 4-10: PCI-104 Slot Location	48
Figure 4-11: Power Button Connector Location	49
Figure 4-12: Reset Button Connector Locations	50
Figure 4-13: Serial Port Connector Location	51
Figure 4-14: RS-232 Serial Port Connector Location	52
Figure 4-15: TFT LCD LVDS Connector Pinout Locations	53
Figure 4-16: Internal USB Connector Location	55
Figure 4-17: WAFER-8522 On-board External Interface Connectors	56
Figure 4-18: LAN Connector	57
Figure 4-19: Serial Port Pinout Locations	58
Figure 4-20: VGA Connector	59
Figure 5-1: SO-DIMM Installation	65

Figure 5-2: CF Card Installation67
Figure 5-3: Enclosure Heat Sink Retention Screws
Figure 5-4: PCI-104 Module Installation (Hexagonal Copper Pillars)68
Figure 5-5: CF Card Setup Jumper Location71
Figure 5-6: JP2 Clear CMOS Jumper72
Figure 5-7: COM Port Setting Jumper Location73
Figure 5-8: LCD Voltage Selection Jumper Location74
Figure 5-9: LCD Resolution Jumper Location75
Figure 5-10: IDE Cable Connection77
Figure 5-11: IDE Cable Connection78
Figure 5-12: Keyboard/mouse Y-cable Connection80
Figure 5-13: Four Serial Port Connector Cable Connection81
Figure 7-1: InstallShield Wizard Preparation Screen
Figure 7-2: Welcome Screen 131
Figure 7-3: License Agreement 131
Figure 7-4: Readme Information 132
Figure 7-5: Restart the Computer 132
Figure 7-6: Audio Driver Install Shield Wizard Starting 133
Figure 7-7: Audio Driver Setup Preparation 133
Figure 7-8: Audio Driver Welcome Screen 134
Figure 7-9: Audio Driver Software Configuration 134
Figure 7-10: Audio Driver Digital Signal 135
Figure 7-11: Audio Driver Installation Begins 135
Figure 7-12: Audio Driver Installation Complete
Figure 7-13: GMA Driver Installation Welcome Screen 137
Figure 7-14: GMA Driver License Agreement 137
Figure 7-15: GMA Driver Installing Notice 138
Figure 7-16: GMA Driver Installation Complete 138
Figure 7-17: LAN License Agreement 139
Figure 7-18: Select the Driver Directory 139
Figure 7-19: LAN Driver Configuration 140

Page xi

3 8.

®Technology Corp.



List of Tables

Table 1-1: WAFER-8522 Board Variations4
Table 1-2: Technical Specifications
Table 2-1: Supported Processors16
Table 2-2: Supported HDD Specifications 20
Table 2-3: Power Consumption27
Table 3-1: Package List Contents
Table 4-1: Peripheral Interface Connectors35
Table 4-2: Rear Panel Connectors
Table 4-3: AT Power Connector Pinouts 37
Table 4-4: ATX Power Connector Pinouts
Table 4-5: Audio Connector Pinouts
Table 4-6: CF Card Socket Pinouts 40
Table 4-7: IDE Connector Pinouts 42
Table 4-8: Inverter Power Connector Pinouts 43
Table 4-9: Keyboard/Mouse Connector Pinouts 44
Table 4-10: LED Connector Pinouts45
Table 4-11: PCI-104 Slot Connector Pinouts 49
Table 4-12: Power Button Connector Pinouts49
Table 4-13: Reset Button Connector Pinouts
Table 4-14: RS-232/422/485 Serial Port Connector Pinouts51
Table 4-15: RS-232 Serial Port Connector Pinouts
Table 4-16: TFT LCD LVDS Port Connector Pinouts54
Table 4-17: Internal USB Connector Pinouts 55
Table 4-18: RJ-45 Ethernet Connector Pinouts
Table 4-19: RJ-45 Ethernet Connector LEDs57
Table 4-20: RS-232 Serial Port (COM 1) Pinouts
Table 4-21: USB Connector Pinouts
Table 4-22: VGA Connector Pinouts 50

Table 5-1: Jumpers	70
Table 5-2: CF Card Setup Jumper Settings	70
Table 5-3: JP2 Clear CMOS Jumper Settings	71
Table 5-4: COM Port Setting Jumper Settings	72
Table 5-5: LCD Voltage Selection Jumper Settings	74
Table 5-6: LCD Resolution Jumper Settings	75
Table 5-7: IEI Provided Cables	76
Table 6-1: BIOS Navigation Keys	85

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BIOS Menus

Menu 1: Main		86
Menu 2: Advanced		88
Menu 3: CPU Config	guration	89
Menu 4: IDE Config	uration	90
Menu 5: IDE Master	and IDE Slave Configuration	94
Menu 6: Super IO C	onfiguration	98
Menu 7: Hardware H	lealth Configuration	104
Menu 8: MPS Config	guration	105
Menu 9: Trusted Co	mputing	106
Menu 10: USB Conf	iguration	107
Menu 11: USB Mass	Storage Device Configuration	109
Menu 12: Boot		111
Menu 13: Boot Setti	ngs Configuration	112
Menu 14: Boot Devi	ce Priority Settings	114
Menu 15: Removabl	le Drives	115
Menu 16: Security		116
Menu 17: Chipset		117
Menu 18:NorthBridg	ge Chipset Configuration	118
Menu 19:SouthBridg	ge Chipset Configuration	123
Menu 20:Power		124
Menu 21:Exit		126

Page xiv

Glossary

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AC '97	Audio Codec 97		
ACPI	Advanced Configuration and		
	Power Interface		
APM	Advanced Power Management		
ARMD	ATAPI Removable Media Device		
ASKIR	Shift Keyed Infrared		
ATA	Advanced Technology		
	Attachments		
BIOS	Basic Input/Output System		
CFII	Compact Flash Type 2		
CMOS	Complementary Metal Oxide		
	Semiconductor		
CPU	Central Processing Unit		
Codec	Compressor/Decompressor		
COM	Serial Port		
DAC	Digital to Analog Converter		
DDR	Double Data Rate		
DIMM	Dual Inline Memory Module		
DIO	Digital Input/Output		
DMA	Direct Memory Access		
EIDE	Enhanced IDE		
EIST	Enhanced Intel SpeedStep		
	Technology		
FFIO	Flexible File Input/Output		
FIFO	First In/First Out		
FSB	Front Side Bus		
IrDA	Infrared Data Association		
HDD	Hard Disk Drive		

IDE	Integrated Data Electronics
I/O	Input/Output
ICH4	I/O Controller Hub 4
L1 Cache	Level 1 Cache
L2 Cache	Level 2 Cache
LCD	Liquid Crystal Display
LPT	Parallel Port Connector
LVDS	Low Voltage Differential Signaling
MAC	Media Access Controller
OS	Operating System
PCI	Peripheral Connect Interface
PIO	Programmed Input Output
PnP	Plug and Play
POST	Power On Self Test
RAM	Random Access Memory
SATA	Serial ATA
S.M.A.R.T	Self Monitoring Analysis and
	Reporting Technology
SPD	Serial Presence Detect
S/PDI	Sony/Philips Digital Interface
SDRAM	Synchronous Dynamic Random
	Access Memory
SIR	Serial Infrared
UART	Universal Asynchronous
	Receiver-transmitter
USB	Universal Serial Bus
VGA	Video Graphics Adapter

Page xv

3 8.



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Introduction





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The WAFER-8522 is a fanless single board computer using the Intel® Celeron® M processor with high performance and low power consumption. The WAFER-8522 is shipped with an enclosure heat sink for maximum heat dissipation. The WAFER-8522 also comes with an expansion PCI-104 slot which allows flexible implementations. The WAFER-8522 supports various peripheral device interfaces, including Ethernet ports, serial ports, USB 2.0 ports and VGA port. Multiple display support adds versatility to the system enabling system integrators and designers increased flexibility in selecting display panel options.

1.1.1 WAFER-8522 Board Variations

WAFER-8522	CPU	Clock Speed—	Cashe	FSB	ТРМ
		Ultra Low Voltage			
-1GZ-R10	Intel Celeron M	1 GHz	Zero cache	400 MHz	No
-600-R10	Intel Celeron M	600 MHz	512 KB L2 cache	400 MHz	No
T-1GZ-R10	Intel Celeron M	1 GHz	Zero cache	400 MHz	Yes
T-600-R10	Intel Celeron M	600 MHz	512 KB L2 cache	400 MHz	Yes

Four IEI WAFER-8522 models are available. The models are listed in Table 1-1.

Table 1-1: WAFER-8522 Board Variations

1.1.2 WAFER-8522 Applications

The WAFER-8522 is designed for applications in the following areas:

- Kiosks and Point of Sales
- Restaurants
- Human Machine Interface (HMI) applications
- Marine, GPS and transportation applications
- Financial, retail and kiosk applications

1.1.3 WAFER-8522 Benefits

Page 4

Some of the WAFER-8522 benefits include:

- Reduced hardware costs
- Reduced software costs
- Reduced maintenance costs
- Client crash prevention
- Central resource control
- Security protection

1.1.4 WAFER-8522 Features

Some of the WAFER-8522 features are listed below:

- 3.5" form factor
- RoHS compliant
- Fanless design
- ULV Intel® Celeron® M processor installed
- Digital dual-independent display functionality
- Two high performance gigabit Ethernet controllers on-board
- CPU and chipset on the solder side for easy system thermal control

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- CompactFlash[®] card and PCI-104 slot solutions
- Integrated audio
- TPM v1.2 hardware security function supported





1.2 WAFER-8522 Board Overview



Figure 1-1: WAFER-8522 Overview



Figure 1-2: WAFER-8522 Solder Side Overview

Page 6

1.2.1 WAFER-8522 Connectors

The WAFER-8522 has the following connectors on-board:

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- 1 x AT power connector
- 1 x ATX power connector
- 1 x Audio connector
- 1 x Compact Flash (CF) connector
- 1 x IDE Interface connector
- 1 x Inverter connector
- 1 x Keyboard/mouse connector
- 1 x LED connector
- 1 x PCI-104 connector
- 1 x Power button connector
- 1 x Reset button connector
- 1 x RS-232/422/485 serial port connector
- 1 x RS-232 serial port connector (COM3~COM6)
- 1 x TFT LCD LVDS connector
- 1 x USB connector

The WAFER-8522 has the following connectors on the board rear panel:

- 1 x VGA connector
- 1 x Serial port connector
- 2 x USB 2.0 connectors
- 2 x LAN RJ-45 connectors

The WAFER-8522 has the following on-board jumpers:

- Clear CMOS
- CF Card Setup
- COM Port Jumper Settings
- LCD Voltage Setup
- LCD Panel Resolution Setup





1.2.2 Technical Specifications

WAFER-8522 technical specifications are listed in **Table 1-2**. Detailed descriptions of each specification can be found in **Chapter 2**.

Specification	WAFER-8522			
CPU (On-board)	Intel [®] Celeron M 600Mhz 512K cache / 1.0GHz zero cache			
System Chipset	Intel [®] 852GM + ICH4			
Display	CRT integrated in Intel [®] 852GM			
Display	Dual channel 18-bit LVDS			
Memory	Supports one 200-pin DDR 266 SO-DIMM module up to 1GB			
BIOS	AMI BIOS			
SSD	CompactFlash® Type II			
Audio	AC'97 Codec Realtek ALC655			
LAN	Dual Realtek RTL8110SC GbE			
COM	Five RS-232 and			
COM	One RS-232/RS-422/RS-485			
USB2.0	Four USB 1.1 or USB 2.0 devices supported			
IDE	One 44-pin IDE connects to two Ultra ATA33/66/100 devices			
ТРМ	One TPM v1.2 module (SINOSUN SSX35) onboard			
Watchdog Timer	Software programmable 1-255 sec. by supper I/O			
IrDA	One IrDA connector			
Expansion	One PCI-104 slot			
Power Supply	AT/ATX power support			

Page 8

Temperature	0°C - 60°C
Humidity (operating)	5%~95% non-condensing
Dimensions	146mm x 102mm
Weight (GW/NW)	700g/175g

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Table 1-2: Technical Specifications





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Detailed Specifications





2.1 Overview

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This chapter describes the specifications and on-board features of the WAFER-8522 in detail.

2.2 Dimensions

2.2.1 Board Dimensions

The dimensions of the board are listed below:



Figure 2-1: WAFER-8522 Dimensions (mm)

2.2.2 External Interface Panel Dimensions

External peripheral interface connector panel dimensions are shown in Figure 2-2.

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Figure 2-2: External Interface Panel Dimensions (mm)

2.2.3 Enclosure Heat Sink Dimensions

The dimensions of the WAFER-8522 with the enclosure heat sink are shown in **Figure 2-3**.





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WAFER-8522 Motherboard



Figure 2-3: Enclosure Heat Sink Dimensions (mm)



2.3 Data Flow

The WAFER-8522 motherboard comes with an Intel[®] Celeron M CPU. **Figure 2-4** shows the data flow between the system chipset, the CPU and other components installed on the motherboard.

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Figure 2-4: Data Flow Block Diagram





2.4 Compatible Processor

2.4.1 CPU Overview

The ULV Intel[®] Celeron[®] M processor is installed on the WAFER-8522 motherboard. Specifications for the processors are listed in **Table 2-1** below:

Family	Architecture	Cache	Clock Speed	FSB
ULV Intel® Celeron® M	90 nm	512 KB L2	1.0 GHz	400 MHz
ULV Intel® Celeron [®] M	90 nm	512 KB L2	600 MHz	400 MHz

Table 2-1: Supported Processors

2.4.2 Intel[®] Celeron[®] M

The (ULV) Intel® Celeron® M processor comes with the following features:

- Intel® Streaming SIMD Extensions accelerates 3D graphics performance, video decoding/encoding, and speech recognition.
- Advanced power management features
- Compatible with IA-32 software.
- Advanced branch prediction and data prefetch logic

2.5 Intel[®] 855GME Chipset Graphics Memory Controller Hub

2.5.1 Intel[®] 852GM Overview

The Intel® 852GM chipset comes with the following features:

- Supports Intel® NetBurst® micro-architecture
- 400 MHz system bus delivers a high-bandwidth connection between the processor and the platform
- Supports integrated graphics utilizing Intel® Extreme Graphics 2 technology
- Three USB host controllers provide high performance peripherals with 480
 Mbps of bandwidth, while enabling support for up to six USB 2.0 ports.
- The latest AC '97 implementation delivers 20-bit audio for enhanced sound quality and full surround-sound capability.



 LAN Connect Interface (LCI) provides flexible network solutions such as 10/100 Mbps Ethernet and 10/100 Mbps Ethernet with LAN manageability

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- Dual Ultra ATA/100 controllers, coupled with the Intel® Application Accelerator supports faster IDE transfers to storage devices
- Intel Application Accelerator software provides additional performance over native ATA drivers by improving I/O transfer rates and enabling faster O/S load time, resulting in accelerated boot times

2.5.2 Intel[®] 852GM Memory Support

The Intel[®] 852GM supports one DDR memory module with frequencies up to 266MHz. The WAFER-8522 has one 200-pin DDR SDRAM SO-DIMM socket that supports one 200MHz or 266MHz DDR SO-DIMM memory module with a maximum capacity of 1GB.

2.5.3 Intel[®] 852GM Internal Graphics Controller

The Intel® Extreme Graphics 2 is integrated on the Intel® 852GM Northbridge chipset. The Intel® Extreme Graphics 2 features are listed below.

- Enhanced Rapid Pixel and Texel Rendering: Optimized visual quality and performance from the addition of hardware to support of texel formatting, bicubic filter, color blending accuracy, and video mixing render, resulting in optimized visual quality and performance.
- Zone Rendering 2 Technology: Enhances the performance of zone rendering by using larger zones and new commands that improve graphics pipeline efficiency.
- Dynamic Video Memory Technology v2.0: Increases total system performance by optimizing the efficiency of AGP dynamic video memory by increasing its size of Video RAM allocation to 96 MB.
- Enhanced Intelligent Memory Management: Improves memory bandwidth efficiency and platform performance by improving the memory management arbitration between CPU, system memory and graphics memory.

Intel® Extreme Graphics 2 specifications are listed below:

Enhanced 2D:



- O 256-bit internal path
- O 8/16/32bpp

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- O DirectDraw*, GDI, GDI+
- O Anti-aliased text support
- O Alpha blending
- O Alphas stretch blitter
- O Hardware alpha blended RGB cursor
- O Color space conversion
- O 5x2 overlay support
- O Rotate, scale and translate operations
- High-performance 3D:
 - O 256-bit internal path
 - O 32bpp/ 24ZorW/ 8 Stencil
 - O DX7*/DX8*/OGL*1.1
 - O DXTn texture compression
 - O Up to 4 textures / pixel on a single pass
 - O Cubic reflection map
 - O Embossed/DOT3 bump mapping
 - O Multi-texture
 - DOT3 bump-mapping
 - O Point sprites
- Video and Display:
 - O DirectShow*/DirectVA*
 - O Hardware motion compensation support for DVD playback
 - O 4x2 overlay filter
 - O 350 MHz DAC frequency
 - O Maximum DVO pixel rate of up to 330MP/s
 - Flat panel monitors and TV-out support via AGP Digital Display (ADD) cards
 - 350 MHz DAC for 1800x1440 @ 85Hz max CRT resolution or 2048x1536@60Hz max FP resolution
 - O Synchronous display for dual monitor capabilities
 - O 350MHz RAMDAC for up to QXGA analog monitor support
 - O Dual DVO ports for up to QXGA digital display support
- Multiple display types (LVDS, DVI, TV-out, CRT)



2.6 Intel[®] 82801DB I/O Controller Hub (ICH4)

2.6.1 Intel[®] ICH4 Overview

The Intel[®] ICH4 I/O controller hub comes with the following features:

 PCI Local Bus Specification, Revision 2.2-compliant with support for 33 MHz PCI operations.

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- ACPI Power Management Logic Support
- Enhanced DMA controller, Interrupt controller, and timer functions
- Integrated IDE controller supports Ultra ATA100/66/33
- USB host interface with support for 4 USB ports; 3 UHCI host controllers; 1 EHCI high-speed
- USB 2.0 Host controller
- Integrated LAN controller
- System Management Bus (SMBus) Specification, Version 2.0 with additional support for I2C devices
- Supports Audio Codec '97, Revision 2.3 specification
- Low Pin Count (LPC) interface
- Firmware Hub (FWH) interface support
- Alert On LAN* (AOL) and Alert On LAN 2* (AOL2)

2.6.2 Intel[®] ICH4 IDE Interface

The single WAFER-8522 IDE connector supports two IDE hard disks and ATAPI devices. PIO IDE transfers up to 16MB/s and Ultra ATA transfers of 100MB/s. The integrated IDE interface is able to support the following IDE HDDs:

The onboard ATA-6 controller is able to support the following IDE HDDs:

- Ultra ATA/100, with data transfer rates up to 100MB/s
- Ultra ATA/66, with data transfer rates up to 66MB/s
- Ultra ATA/33, with data transfer rates up to 33MB/s



Specification	Ultra ATA/100	Ultra ATA/66	Ultra ATA/100
IDE devices	2	2	2
PIO Mode	0 – 4	0 – 4	0 – 4
PIO Max Transfer Rate	16.6 MB/s	16.6 MB/s	16.6 MB/s
DMA/UDMA designation	UDMA 3 - 4	UDMA 3 – 4	UDMA 2
DMA/UDMA Max Transfer	100MB/s	66MB/s	33MB/s
Controller Interface	5V	5V	5V

Table 2-2: Supported HDD Specifications

2.6.3 Intel[®] ICH4 Compact Flash Interface

The WAFER-8522 CompactFlash socket supports standard CF Type II cards. The chipset flash interface is multiplexed with an IDE interface and can be connected to an array of industry standard NAND Flash or NOR Flash devices.

2.6.4 Intel[®] ICH4 Audio Codec 97 (AC'97) Controller

The WAFER-8522 has an integrated REALTEK ALC655 CODEC. The ALC655 CODEC is a 16-bit, full-duplex AC'97 Rev. 2.3 compatible six-channel audio CODEC designed for PC multimedia systems, including host/soft audio and AMR/CNR-based designs. Some of the features of the codec are listed below.

- Meets performance requirements for audio on PC99/2001 systems
- Meets Microsoft WHQL/WLP 2.0 audio requirements
- 16-bit Stereo full-duplex CODEC with 48KHz sampling rate
- Compliant with AC'97 Rev 2.3 specifications
- Front-Out, Surround-Out, MIC-In and LINE-In Jack Sensing
- 14.318MHz -> 24.576MHz PLL to eliminate crystal
- 12.288MHz BITCLK input
- Integrated PCBEEP generator to save buzzer
- Interrupt capability
- Three analog line-level stereo inputs with 5-bit volume control, LINE_IN, CD,

Page 20

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AUX

- High-quality differential CD input
- Two analog line-level mono inputs: PCBEEP, PHONE-IN
- Two software selectable MIC inputs
- Dedicated Front-MIC input for front panel applications (software selectable)

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- Boost preamplifier for MIC input
- LINE input shared with surround output; MIC input shared with Center and LFE output
- Built-in 50mW/20ohm amplifier for both Front-out and Surround-Out
- External Amplifier Power Down (EAPD) capability
- Power management and enhanced power saving features
- Supports Power-Off CD function
- Adjustable VREFOUT control
- Supports 48KHz S/PDIF output, complying with AC'97 Rev 2.3 specifications
- Supports 32K/44.1K/48KHz S/PDIF input
- Power support: Digital: 3.3V; Analog: 3.3V/5V
- Standard 48-pin LQFP package
- EAXTM 1.0 & 2.0 compatible
- Direct Sound 3DTM compatible
- A3DTM compatible
- I3DL2 compatible
- HRTF 3D positional audio
- 10-band software equalizer
- Voice cancellation and key shifting in Karaoke mode
- AVRack® Media Player
- Configuration Panel for improved user convenience

2.6.5 Intel[®] ICH4 USB Controller

Two external USB ports on the WAFER-8522 board are interfaced to the chipset USB controller. Four USB 1.1 or USB 2.0 devices can be connected simultaneously to the WAFER-8522. The chipset USB controller has the following specifications:

- 4 USB ports
- USB 1.1 and USB 2.0 compliant





- 3 Universal Host Controller Interface (UHCI) controllers
- High-speed, full-speed and low-speed capable

2.6.6 Intel[®] ICH4 PCI Interface

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The PCI interface on the ICH4 is compliant with the PCI Revision 2.2 implementation. Some of the features of the PCI interface are listed below.

- PCI Revision 2.2 compliant
- 33MHz
- 5V tolerant PCI signals (except PME#)
- Integrated PCI arbiter supports up to six PCI bus masters

2.6.7 Intel[®] ICH4 Low Pin Count (LPC) Interface

The ICH4 LPC interface complies with the LPC 1.0 specifications. The LPC bus from the ICH4 is connected to the following components:

- BIOS chipset
- Super I/O chipset

2.6.8 BIOS

The BIOS flash memory chip on the WAFER-8522 has a licensed copy of AMI BIOS loaded onto it. The BIOS flash memory chip is connected to the chipset via the LPC bus. The flash BIOS features are listed below:

- SMIBIOS (DMI) compliant
- Console redirection function support
- PXE (Pre-Boot Execution Environment) support
- USB booting support

2.7 PCI Bus Components

2.7.1 PCI Bus Overview

Page 22
The PCI bus controller on the ICH4 is compliant with PCI Revision 2.2 specifications and has a 33MHz PCI clock. The components listed below are all connected to the PCI bus:

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- PCI-104 socket
- Realtek RTL8110SC GbE interface

2.7.2 GbE Ethernet

A highly integrated and cost-effective single-chip, fast RealTek RTL8110SC GbE Ethernet controller is interfaced through first the PCI bus to the CPU and system chipset. The RealTek RTL8110SC controller provides 10Mbps, 100Mbps or 1000Mbps Ethernet connectivity to the WAFER-8522. Some of the features of the RealTek RTL8110SC are listed below.

- Integrated 10/100/1000 transceiver
- Auto-Negotiation with Next Page capability
- Supports PCI rev.2.3, 32-bit, 33/66MHz
- Supports CLKRUNB and MiniPCI v1.0
- Supports pair swap/polarity/skew correction
- Crossover Detection & Auto-Correction
- Wake-on-LAN and remote wake-up support
- Microsoft® NDIS5 Checksum Offload (IP, TCP, UDP) and largesend offload support
- Supports Full Duplex flow control (IEEE 802.3x)
- Fully compliant with IEEE 802.3, IEEE 802.3u, IEEE 802.3ab
- Supports IEEE 802.1P Layer 2 Priority Encoding
- Supports IEEE 802.1Q VLAN tagging
- Serial EEPROM
- 3.3V signaling, 5V PCI I/O tolerant
- Transmit/Receive FIFO (8K/64K) support
- Supports power down/link down power saving
- Supports PCI Message Signaled Interrupt (MSI)





2.7.3 PCI-104 Slot

The PCI-104 socket supports PCI-104 modules that are compliant with PCI Specification, Revision 1.0. The PCI-104 modules are easily installed into the socket. The standard PCI-104 modules are 95.89mm wide, 90.17mm long.

2.8 LPC Bus Components

2.8.1 LPC Bus Overview

The LPC bus is connected to components listed below:

- BIOS chipset
- Super I/O chipset

2.8.2 BIOS Chipset

The BIOS chipset has a licensed copy of AMI BIOS installed on the chipset. Some of the BIOS features are listed below:

- AMI Flash BIOS
- SMIBIOS (DMI) compliant
- Console redirection function support
- PXE (Pre-boot Execution Environment) support
- USB booting support

2.8.3 Super I/O Chipset

The iTE IT8712F Super I/O chipset is connected to the ICH4 through the LPC bus. The iTE IT8712F is an LPC interface-based Super I/O device that comes with Environment Controller integration. Some of the features of the iTE IT8712F chipset are listed below:

- LPC Interface
- PC98/99/2001, ACPI and LANDesk Compliant
- Enhanced Hardware Monitor
- SmartGuardian Controller
- Single +5V Power Supply

- Two 16C550 UARTs for serial port control
- One IEEE 1284 Parallel Port
- Keyboard Controller
- Watchdog Timer
- Serial IRQ Support
- Vbat & Vcch Support
- Single +5V Power Supply

Some of the Super I/O features are described in more detail below:

2.8.3.1 Super I/O 16C550 UARTs

The onboard Super I/O has two integrated 16C550 UARTs that can support the following:

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- Two standard serial ports (COM1 and COM2)
- IrDa 1.0 and ASKIR protocols

Another chipset connected to the LPC bus provided connectivity to another four serial port connectors (COM3, COM4, COM5 and COM6).

2.8.3.2 Super I/O Keyboard Controller

The Super I/O keyboard controller can execute the 8042 instruction set. Some of the keyboard controller features are listed below:

- The 8042 instruction is compatible with a PS/2 keyboard and PS/2 mouse
- Gate A20 and Keyboard reset output
- Supports multiple keyboard power on events
- Supports mouse double-click and/or mouse move power on events

2.9 TPM Module

The WAFER-8522 has one SINOSUN SSX35 TPM v1.2 module on-board. Some of the TPM module features are listed below:

- Fully compatible with TCG v1.2 Specifications
- SINOSUN 8-bit CPU core
- Embedded 16KB secure data FLASH memory and 16KB RAM





- 128KB program FLASH memory supporting online update of firmware
- RSA engine supports up to 2048 bits RSA algorithm
- Embedded SHA-1 algorithm engine

2.10 Environmental and Power Specifications

2.10.1 System Monitoring

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Three thermal inputs on the WAFER-8522 Super I/O Enhanced Hardware Monitor monitor the following temperatures:

- System temperature
- Temperature Sensor #1

Eight voltage inputs on the WAFER-8522 Super I/O Enhanced Hardware Monitor monitor the following voltages:

- CPU Core
- VCC
- +3.3V
- +5.0V
- +1.5V
- VBAT

Page 26

The WAFER-8522 Super I/O Enhanced Hardware Monitor also monitors the CPU fan speeds.

2.10.2 Operating Temperature and Temperature Control

The maximum and minimum operating temperatures for the WAFER-8522 are listed below.

- Minimum Operating Temperature: 0°C (32°F)
- Maximum Operating Temperature: 60°C (140°F)

A cooling fan and heat sink must be installed on the CPU. Thermal paste must be smeared on the lower side of the heat sink before it is mounted on the CPU. Heat sinks

are also mounted on the northbridge and southbridge chipsets to ensure the operating temperature of these chips remain low.

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2.10.3 Power Consumption

Table 2-3 shows the power consumption parameters for the WAFER-8522 when an Intel[®] Celeron[®] M 1.0GHz CPU is running with one 1GB 400MHz DDR SDRAM memory module.

Voltage	Current	
5V	3.43A	
12V	0.13A	

 Table 2-3: Power Consumption





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Unpacking



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3.1 Anti-static Precautions



Failure to take ESD precautions during the installation of the WAFER-8522 may result in permanent damage to the WAFER-8522 and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the WAFER-8522. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the WAFER-8522, or any other electrical component is handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- Self-grounding:- Before handling the board touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.
- Use an anti-static pad: When configuring the WAFER-8522, place it on an antic-static pad. This reduces the possibility of ESD damaging the WAFER-8522.
- Only handle the edges of the PCB:-: When handling the PCB, hold the PCB by the edges.

3.2 Unpacking

3.2.1 Unpacking Precautions

When the WAFER-8522 is unpacked, please do the following:

- Follow the anti-static precautions outlined in **Section 3.1**.
- Make sure the packing box is facing upwards so the WAFER-8522 does not fall out of the box.
- Make sure all the components shown in **Section 3.3** are present.



3.3 Unpacking Checklist



If some of the components listed in the checklist below are missing, please do not proceed with the installation. Contact the IEI reseller or vendor you purchased the WAFER-8522 from or contact an IEI sales representative directly. To contact an IEI sales representative, please send an email to sales@iei.com.tw.

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3.3.1 Package Contents

The WAFER-8522 is shipped with the following components:

Quantity	Item	Image
1	WAFER-8522 single board computer	
1	Enclosure heat sink	
1	Audio cable	
1	IDE flat cable 44p/44p	
1	PS2 keyboard/mouse cable	





Table 3-1: Package List Contents

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Connector Pinouts





4.1 Peripheral Interface Connectors

Section 4.1.2 shows peripheral interface connector locations. Section 4.1.2 lists all the peripheral interface connectors seen in Section 4.1.2.

4.1.1 WAFER-8522 Layout

Figure 4-1 shows the on-board peripheral connectors, rear panel peripheral connectors and on-board jumpers.



Figure 4-1: Connector and Jumper Locations

4.1.2 Peripheral Interface Connectors

Page 34

Table 4-1 shows a list of the peripheral interface connectors on the WAFER-8522.Detailed descriptions of these connectors can be found below.

Connector	Туре	Label
AT power connector	4-pin wafer connector	CN5
ATX power connector	3-pin wafer connector	CN8
Audio connector	10-pin box header	CN4
Compact Flash (CF) connector	50-pin CF slot	CF1
IDE Interface connector	44-pin box header	IDE1
Inverter connector	5-pin wafer connector	CN10
Keyboard/mouse connector	6-pin wafer connector	KB1
LED connector	6-pin header	CN3
PCI-104 connector	PCI-104 slot	J1
Power button connector	2-pin wafer connector	CN7
Reset button connector	2-pin wafer connector	CN6
RS-232/422/485 serial port connector	14-pin header	COM2
RS-232 serial port connector (COM3~COM6)	40-pin header	CN9
TFT LCD LVDS connector	30-pin crimp connector	LVDS1
USB connector	8-pin header	USB1

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 Table 4-1: Peripheral Interface Connectors

4.1.3 External Interface Panel Connectors

 Table 4-2 lists the rear panel connectors on the WAFER-8522. Detailed descriptions of these connectors can be found in Section 4.2.15 on page 54.

Connector	Туре	Label
Ethernet connectors	RJ-45 connector	LAN1, LAN2





RS-232 serial port connector	DB-9 connector	COM1
USB ports	USB port	J2
VGA port connector	15-pin female	VGA1

Table 4-2: Rear Panel Connectors

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4.2 Internal Peripheral Connectors

Internal peripheral connectors are found on the motherboard and are only accessible when the motherboard is outside of the chassis. This section has complete descriptions of all the internal, peripheral connectors on the WAFER-8522.

4.2.1 AT Power Connector

CN Label:	CN5
CN Type:	4-pin wafer connector (1x4)
CN Location:	See Figure 4-2
CN Pinouts:	See Table 4-3

The 4-pin AT power connector is connected to an AT power supply.



Figure 4-2: AT Power Connector Location

PIN NO.	DESCRIPTION	
1	+12V	
2	GROUND	
3	GROUND	
4	+5V	

Table 4-3: AT Power Connector Pinouts

4.2.2 ATX Power Connector

CN Label:	CN8
CN Type:	3-pin wafer connector (1x3)
CN Location:	See Figure 4-3
CN Pinouts:	See Table 4-4

The 3-pin ATX power connector is connected to an ATX power supply.

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Figure 4-3: ATX Power Connector Location

PIN NO.	DESCRIPTION	
1	+5V_SB	
2	GROUND	





3	PS_ON

Table 4-4: ATX Power Connector Pinouts

4.2.3 Audio Connector

CN Label:	CN4
CN Type:	10-pin box header (2x5)
CN Location:	See Figure 4-4
CN Pinouts:	See Table 4-5

The 10-pin audio connector is connected to speakers the output of audio signals from the system.



Figure 4-4: Audio Connector Pinouts

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	LINEOUT_R	2	LINEIN_R
3	GROUND	4	GROUND
5	LINEOUT_L	6	LINEIN_L
7	GROUND	8	GROUND
9	MIC1IN	10	MIC2IN

Table 4-5: Audio Connector Pinouts



4.2.4 Compact Flash Socket

CN Label:	CF1
СN Туре:	50-pin CF slot (2x25)

CN Location: See Figure 4-5

CN Pinouts: See Table 4-6

A CF Type II memory card is inserted to the CF socket of the WAFER-8522.

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Figure 4-5: CF Card Socket Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	GROUND	26	GROUND



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2	D3	27	D11
3	D4	28	D12
4	D5	29	D13
5	D6	30	D14
6	D7	31	D15
7	CS1#	32	CS3#
8	N/C	33	N/C
9	GROUND	34	IOR#
10	N/C	35	IOW#
11	N/C	36	VCC
12	N/C	37	IRQ15
13	VCC	38	VCC
14	N/C	39	MASTER/SLAVE
15	N/C	40	N/C
16	N/C	41	RESET#
17	N/C	42	IORDY
18	A2	43	DMARQ
19	A1	44	DMACK#
20	AO	45	ACTIVE#
21	DO	46	PDI AG#
22	D1	47	D8
23	D2	48	D9
24	N/C	49	D10
25	GROUND	50	GROUND

Table 4-6: CF Card Socket Pinouts

4.2.5 IDE Connector

CN Label:	IDE1
CN Type:	44-pin box header (2x22)
CN Location:	See Figure 4-6
CN Pinouts:	See Table 4-7

One 44-pin IDE device connector on the WAFER-8522 supports connectivity to two hard disk drives.

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Figure 4-6: IDE Device Connector Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	RESET#	2	GROUND
3	DATA 7	4	DATA 8
5	DATA 6	6	DATA 9
7	DATA 5	8	DATA 10
9	DATA 4	10	DATA 11
11	DATA 3	12	DATA 12



13	DATA 2	14	DATA 13
15	DATA 1	16	DATA 14
17	DATA O	18	DATA 15
19	GROUND	20	N/C
21	DMARQ	22	GROUND
23	IOW#	24	GROUND
25	IOR#	26	GROUND
27	IORDY	28	BALE
29	DMACK#	30	GROUND
31	INTERRUPT	32	N/C
33	SA1	34	PDIAG
35	SAO	36	SA2
37	HDC CS0#	38	HDC CS1#
39	HDD ACTIVE#	40	GROUND
41	+5V	42	+5V
43	GROUND	44	N/C

Table 4-7: IDE Connector Pinouts

4.2.6 Inverter Power Connector

CN Label:	CN10
CN Type:	5-pin wafer connector (1x5)
CN Location:	See Figure 4-7
CN Pinouts:	See Table 4-8

The inverter connector is connected to the LCD backlight.



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Figure 4-7: Inverter Connector Location

PIN NO.	DESCRIPTION
1	INV_ADJ
2	GND
3	+12V
4	GND
5	(H)ON/OFF(L)

 Table 4-8: Inverter Power Connector Pinouts

4.2.7 Keyboard/Mouse Connector

CN Label:	KB1
CN Type:	6-pin wafer connector (1x6)
CN Location:	See Figure 4-8
CN Pinouts:	See Table 4-9

The keyboard/mouse connector can be connected to a standard PS/2 cable or PS/2 cable to add keyboard and mouse functionality to the system.







Figure 4-8: Keyboard/Mouse Connector Location

PIN NO.	DESCRIPTION
1	+5V
2	MS DATA
3	MS CLK
4	KB DATA
5	KB CLK
6	GROUND

Table 4-9: Keyboard/Mouse Connector Pinouts

4.2.8 LED Connector

CN Label:	CN3
CN Type:	6-pin header (1x6)
CN Location:	See Figure 4-9
CN Pinouts:	See Table 4-10

The LED connector connects to an HDD indicator LED and a power LED on the system chassis to inform the user about HDD activity and the power on/off status of the system.





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Figure 4-9: LED Connector Locations

PIN NO.	DESCRIPTION
1	+5V
2	GROUND
3	+5V
4	GROUND
5	HDLED+
6	HDLED-

Table 4-10: LED Connector Pinouts

4.2.9 PCI-104 Slot

CN Label: J1

CN Type: 120-pin PCI-104 slot

CN Location: See Figure 4-10

CN Pinouts: See Table 4-11

The PCI-104 slot enables a PCI-104 compatible expansion module to be connected to the board.



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Page 47



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Pin No.	Column A	Column B	Column C	Column D
1	GND/5V	TBD1	5V	AD00
2	VI/01	AD02	AD01	+5V
3	AD05	GND	AD04	AD03
4	C/BEO#	AD07	GND	AD06
5	GND	AD09	AD08	GND
6	AD11	VI/02	AD10	M66EN
7	AD14	AD13	GND	AD12
8	+3.3V	C/BE1#	AD15	+3.3V
9	SERR#	GND	SBO#	PAR
10	GND	PERR#	+3.3V	SDONE
11	STOP#	+3.3V	LOCK#	GND
12	+3.3V	TRDY#	GND	DEVSEL#
13	FRAME#	GND	IRDY#	+3.3V
14	GND	AD16	+3.3V	C/BE2#
15	AD18	+3.3V	AD17	GND
16	AD21	AD20	GND	AD19
17	+3.3V	AD23	AD22	+3.3V
18	IDSELO	GND	IDSEL1	IDSEL2
19	AD24	C/BE3#	VI/01	IDSEL3
20	GND	AD26	AD25	GND
21	AD29	+5V	AD28	AD27
22	+5V	AD30	GND	AD31
23	REQ0#	GND	REQ1#	VI/02
24	GND	REQ2#	+5V	GNTO#
25	GNT1#	VI/03	GNT2#	GND
26	+5V	CLKO	GND	CLK1
27	CLK2	+5V	CLK3	GND

28	GND	INTD#	+5V	RST#
29	+12V	INTA#	INTB#	INTC#
30	-12V	TBD2	TBD	GND/3.3V

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Table 4-11: PCI-104 Slot Connector Pinouts

4.2.10 Power Button Connector

CN Label:	CN7
CN Type:	2-pin wafer connector (1x2)
CN Location:	See Figure 4-11
CN Pinouts:	See Table 4-12

The power button connector is connected to a power switch on the system chassis to enable users to turn the system on and off.



Figure 4-11: Power Button Connector Location

PIN NO.	DESCRIPTION
1	Button+
2	Button-

Table 4-12: Power Button Connector Pinouts

4.2.11 Reset Button Connector





CN Label:	CN6
CN Type:	2-pin wafer connector (1x2)
CN Location:	See Figure 4-12
CN Pinouts:	See Table 4-13

The reset button connector is connected to a reset switch on the system chassis to enable users to reboot the system when the system is turned on.



Figure 4-12: Reset Button Connector Locations

PIN NO.	DESCRIPTION
1	RESET#
2	GROUND

 Table 4-13: Reset Button Connector Pinouts

4.2.12 Serial Port Connector (RS-232/422/485)

CN Label: COM2

Page 50

- **CN Type:** 14-pin header (2x7)
- CN Location: See Figure 4-13
- CN Pinouts: See Table 4-14

The serial port connectors connect to RS-232, RS-422 or RS-485 serial port device.



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Figure 4-13: Serial Port Connector Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	DCD	2	DSR
3	RXD	4	RTS
5	TXD	6	стѕ
7	DTR	8	RI
9	GND	10	GND
11	(RS422/485) TX+	12	(RS422/485) TX-
13	(RS422) RX+	14	(RS422) RX-

Table 4-14: RS-232/422/485 Serial Port Connector Pinouts

4.2.13 Serial Port Connector (COM 3, COM 4, COM 5 and COM 6)

CN Label:	CN9
CN Type:	40-pin header (2x20)
CN Location:	See Figure 4-14
CN Pinouts:	See Table 4-15

The 40-pin serial port connector contains the following four serial ports, COM 3, COM 4, COM 5 and COM 6. All four serial ports are RS-232 serial communications channels. The serial port locations are specified below.

• COM 3 is located on pin 1 to pin 10



COM 4 is located on pin 11 to pin 20

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- COM 5 is located on pin 21 to pin 30
- COM 6 is located on pin 31 to pin 40



Figure 4-14: RS-232 Serial Port Connector Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	DCD_COM3	2	DSR_COM3
3	RXD_COM3	4	RTS_COM3
5	TXD_COM3	6	стѕ_сомз
7	DTR_COM3	8	RI_COM3
9	GND	10	GND
11	DCD_COM4	12	DSR_COM4
13	RXD_COM4	14	RTS_COM4
15	TXD_COM4	16	CTS_COM4
17	DTR_COM4	18	RI_COM4
19	GND	20	GND
21	DCD_COM5	22	DSR_COM5
23	RXD_COM5	24	RTS_COM5
25	TXD_COM5	26	CTS_COM5
27	DTR_COM5	28	RI_COM5
29	GND	30	GND

31	DCD_COM6	32	DSR_COM6
33	RXD_COM6	34	RTS_COM6
35	TXD_COM6	36	CTS_COM6
37	DTR_COM6	38	RI_COM6
39	GND	40	GND

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Table 4-15: RS-232	Serial Port	Connector	Pinouts
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4.2.14 TFT LCD LVDS Connector

CN Label:	J3
CN Type:	30-pin crimp connector (2x15)
CN Location:	See Figure 4-15
CN Pinouts:	See Table 4-16

The 30-pin TFT LCD LVDS can be connected to a TFT LCD screen directly.



Figure 4-15: TFT LCD LVDS Connector Pinout Locations

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	GND	2	GND



3	Rin0+	4	Rin0-
5	Rin1+	6	Rin1-
7	Rin2+	8	Rin2-
9	CLK1+	10	CLK1-
11	Rin3+	12	Rin3-
13	GND	14	GND
15	Rin4+	16	Rin4-
17	Rin5+	18	Rin5-
19	Rin6+	20	Rin6-
21	CLK2+	22	CLK2-
23	Rin7+	24	Rin7-
25	GND	26	GND
27	LCD_VDD	28	LCD_VDD
29	LCD_VDD	30	LCD_VDD

Table 4-16: TFT LCD LVDS Port Connector Pinouts

4.2.15 Internal USB Connectors

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CN Label:	USB1
CN Type:	8-pin header (2x4)
CN Location:	See Figure 4-16
CN Pinouts:	See Table 4-17

One 2x4 pin connector provides connectivity to two USB 2.0 ports. The USB ports are used for I/O bus expansion.





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Figure 4-16: Internal USB Connector Location

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	VCC	2	GROUND
3	DATAO-	4	DATA0+
5	DATA0+	6	DATAO-
7	GROUND	8	VCC

Table 4-17: Internal USB Connector Pinouts

4.3 External Peripheral Interface Connectors

4.3.1 External Peripheral Interface Connector Overview

The WAFER-8522 external peripheral interface connectors are listed below and shown in

Figure 4-17:

- 2 x RJ-45 Ethernet connector
- 1 x Serial communications port
- 2 x USB combo ports
- 1 x VGA port







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4.3.2 RJ-45 Ethernet Connector

CN Label:	LAN1 and LAN2
CN Type:	RJ-45
CN Location:	See Figure 4-17
CN Pinouts:	See Table 4-18

The RJ-45 Ethernet connector on the WAFER-8522 provides connectivity to a GbE Ethernet connection between the WAFER-8522 and a Local Area Network (LAN) through a network hub.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	ТХО+	5	ТХ2-
2	тхо-	6	TX1-
3	TX1+	7	TX3+
4	TX2+	8	ТХ3-

Table 4-18: RJ-45 Ethernet Connector Pinouts



Figure 4-18: LAN Connector

The RJ-45 Ethernet connector has two status LEDs, one green and one yellow. The green LED indicates activity on the port and the yellow LED indicates the port is linked. See **Table 4-19**.

SPEED LED		ACT/LINK LED	
STATUS	DESCRIPTION	STATUS	DESCRIPTION
OFF	10Mbps connection	OFF	No link
ORANGE	100Mbps connection	YELLOW	Linked
GREEN	1Gbps connection	BLINKING	Data Activity

Table 4-19: RJ-45 Ethernet Connector LEDs

4.3.3 Serial Port Connector (COM1)

CN Label:	COM1
CN Type:	DB-9 connector
CN Location:	See Figure 4-17
CN Pinouts:	See Table 4-20 and Figure 4-19

The 9-pin DB-9 COM 1 serial port connector is connected to RS-232 serial communications devices.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	DCD	6	DSR
2	RXD	7	RTS
3	тхр	8	стх
4	DTR	9	RI
5	GND		

Table 4-20: RS-232 Serial Port (COM 1) Pinouts

Page 57

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Figure 4-19: Serial Port Pinout Locations

4.3.4 USB Combo Ports

CN Label:	J2
CN Type:	USB Combo port
CN Location:	See Figure 4-17
CN Pinouts:	See Table 4-21

The two USB combo ports provide connectivity to USB devices. The USB port support both USB 1.1 and USB 2.0.

PIN NO.	DESCRIPTION	PIN NO.	DESCRIPTION
1	USBVCCO	5	USBVCC1
2	USBP0-	6	USBP1-
3	USBP0+	7	USBP1+
4	USBGND0	8	USBGND1

Table 4-21: USB Connector Pinouts

4.3.5 VGA Connector

CN Label:	VGA1
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CN Type: DB15

CN Location: See Figure 4-17
CN Pinouts: See Figure 4-20 and Table 4-22

The standard 15-pin female DB15 VGA connector connects to a CRT or LCD monitor directly.

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PIN	DESCRIPTION	PIN	DESCRIPTION
1	RED	9	+5V
2	GREEN	10	GROUND
3	BLUE	11	NC
4	NC	12	DDCDAT
5	GROUND	13	HSYNC
6	+5V	14	VSYNC
7	GROUND	15	DDCCLK
8	GROUND		

Table 4-22: VGA Connector Pinouts



Figure 4-20: VGA Connector





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Installation





5.1 Anti-static Precautions

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Failure to take ESD precautions during the installation of the WAFER-8522 may result in permanent damage to the WAFER-8522 and severe injury to the user.

Electrostatic discharge (ESD) can cause serious damage to electronic components, including the WAFER-8522. Dry climates are especially susceptible to ESD. It is therefore critical that whenever the WAFER-8522, or any other electrical component is handled, the following anti-static precautions are strictly adhered to.

- Wear an anti-static wristband: Wearing a simple anti-static wristband can help to prevent ESD from damaging the board.
- Self-grounding:- Before handling the board touch any grounded conducting material. During the time the board is handled, frequently touch any conducting materials that are connected to the ground.
- Use an anti-static pad: When configuring the WAFER-8522, place it on an antic-static pad. This reduces the possibility of ESD damaging the WAFER-8522.
- Only handle the edges of the PCB:-: When handling the PCB, hold the PCB by the edges.



5.2 Installation Considerations



The following installation notices and installation considerations should be read and understood before the WAFER-8522 is installed. All installation notices pertaining to the installation of the WAFER-8522 should be strictly adhered to. Failing to adhere to these precautions may lead to severe damage of the WAFER-8522 and injury to the person installing the motherboard.

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5.2.1 Installation Notices



The installation instructions described in this manual should be carefully followed in order to prevent damage to the WAFER-8522, WAFER-8522 components and injury to the user.

Before and during the installation please DO the following:

- Read the user manual:
 - The user manual provides a complete description of the WAFER-8522 installation instructions and configuration options.
- Wear an electrostatic discharge cuff (ESD):
 - Electronic components are easily damaged by ESD. Wearing an ESD cuff removes ESD from the body and helps prevent ESD damage.
- Place the WAFER-8522 on an antistatic pad:
 - When installing or configuring the motherboard, place it on an antistatic pad. This helps to prevent potential ESD damage.
- Turn all power to the WAFER-8522 off:





• When working with the WAFER-8522, make sure that it is disconnected from all power supplies and that no electricity is being fed into the system.

Before and during the installation of the WAFER-8522 DO NOT:

- Remove any of the stickers on the PCB board. These stickers are required for warranty validation.
- Use the product before verifying all the cables and power connectors are properly connected.
- Allow screws to come in contact with the PCB circuit, connector pins, or its components.

5.2.2 Installation Checklist

The following checklist is provided to ensure the WAFER-8522 is properly installed.

- All the items in the packing list are present (see Chapter 4)
- A compatible memory module is properly inserted into the slot (see Chapter 2)
- The CF Type II card is properly installed into the CF socket
- The jumpers have been properly configured
- The WAFER-8522 is installed into a chassis with adequate ventilation
- The correct power supply is being used
- The following devices are properly connected
 - O Audio kit
 - O Power supply
 - O Serial port cables
- The following external peripheral devices are properly connected to the chassis:
 - O VGA screen
 - O RS-232 serial communications device
 - O USB devices





5.3 SO-DIMM Module Installation and CF Card Installation

5.3.1 SO-DIMM Installation



Using incorrectly specified SO-DIMM may cause permanently damage the WAFER-8522. Please make sure the purchased SO-DIMM complies with the memory specifications of the WAFER-8522. SO-DIMM specifications compliant with the WAFER-8522 are listed in **Chapter 2**.

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To install a SO-DIMM into a SO-DIMM socket, please follow the steps below and refer to **Figure 5-1**.



Figure 5-1: SO-DIMM Installation

- Step 1: Locate the SO-DIMM socket. Place the WAFER-8522 on an anti-static pad with the solder side facing up.
- Step 2: Align the SO-DIMM with the socket. The SO-DIMM must be oriented in such a way that the notch in the middle of the SO-DIMM must be aligned with the plastic bridge in the socket.
- Step 3: Insert the SO-DIMM. Push the SO-DIMM chip into the socket at an angle. (See





Figure 5-1)

- Step 4: Open the SO-DIMM socket arms. Gently pull the arms of the SO-DIMM socket out and push the rear of the SO-DIMM down. (See Figure 5-1)
- Step 5: Secure the SO-DIMM. Release the arms on the SO-DIMM socket. They clip into place and secure the SO-DIMM in the socket.

5.3.2 CF Card Installation



The WAFER-8522 can support CF Type II cards. For the complete specifications of the supported CF cards please refer to **Chapter 2**.

To install a CF Type II card onto the WAFER-8522, please follow the steps below:

- Step 1: Locate the CF card socket. Place the WAFER-8522 on an anti-static pad and locate the CF card.
- Step 2: Align the CF card. Make sure the CF card is properly aligned with the CF socket.
- Step 3: Insert the CF card. Gently insert the CF card into the socket making sure the socket pins are properly inserted into the socket. See Figure 5-2.





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Figure 5-2: CF Card Installation

5.3.3 Mounting the WAFER-8522 Embedded Module

The WAFER-8522 embedded module has a standard PCI-104 connector on the front side. Baseboards can be designed by the end user, customized by IEI, or purchased from IEI. For more information visit the IEI webstie (<u>www.ieiworld.com</u>) or contact an IEI sales representative.

To install the module, follow the instructions below.

Step 1: Remove the four retention screws that secure the WAFER-8522 to the enclosure heat sink.





Page 68

WAFER-8522 Motherboard



Figure 5-3: Enclosure Heat Sink Retention Screws

Step 2: Insert four hexagonal copper pillars (M3*25mm) to the retention screw holes.



Figure 5-4: PCI-104 Module Installation (Hexagonal Copper Pillars)

Step 3: Align the PCI-104 connector with the corresponding connector on a compatible module.

- Step 4: Gently push the embedded module down to ensure the connectors are properly connected. Align the retention screw holes in the PCI-104 module with the copper pillars.
- **Step 5:** Re-insert the four previously removed retention screws into the PCI-104 module.

5.4 Jumper Settings



A jumper is a metal bridge that is used to close an electrical circuit. It consists of two metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To CLOSE/SHORT a jumper means connecting the pins of the jumper with the plastic clip and to OPEN a jumper means removing the plastic clip from a jumper.

1-2-3 OF	PEN 2-3	
Jumper		

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Before the WAFER-8522 is installed in the system, the jumpers must be set in accordance with the desired configuration. The jumpers on the WAFER-8522 are listed in **Table 5-1**.

Description	Label	Туре
CF card setup	JP3	2-pin header
Clear CMOS	JP2	2-pin header
COM port select	JP4	3-pin header
LCD voltage select	JP5	3-pin header
LCD panel resolution select	JP1	8-pin header





Table 5-1: Jumpers

5.4.1 CF Card Setup Jumper Settings

Jumper Label:	JP3
Jumper Type:	2-pin header
Jumper Settings:	See Table 5-2
Jumper Location:	See Figure 5-5

The CF Card Setup jumper sets the compact flash card as either the slave device or the master device. Make the necessary jumper setting in accordance with the settings shown in **Table 5-2**.

CF Card Setup	Description	
Short	Master	Default
Open	Slave	

Table 5-2: CF Card Setup Jumper Settings

The location of the CF Card Setup jumper is shown in **Figure 5-5** below.





5.4.2 Clear CMOS Jumper

Jumper Label:	JP2
Jumper Type:	2-pin header
Jumper Settings:	See Table 5-3
Jumper Location:	See Figure 5-6

If the WAFER-8522 fails to boot due to improper BIOS settings, the CMOS can be cleared using the battery connector. Disconnect the battery from the connector for a few seconds then reconnect the battery. The CMOS should be cleared.

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If the "CMOS Settings Wrong" message is displayed during the boot up process, the fault may be corrected by pressing the F1 to enter the CMOS Setup menu. Do one of the following:

- Enter the correct CMOS setting
- Load Optimal Defaults
- Load Failsafe Defaults.

After having done one of the above, save the changes and exit the CMOS Setup menu.

The clear CMOS jumper settings are shown in Table 5-3.

Clear CMOS	Description	
Open	Keep CMOS Setup	Default
Short	Clear CMOS Setup	

Table 5-3: JP2 Clear CMOS Jumper Settings

The location of the clear CMOS jumper is shown in **Figure 5-6** below.



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WAFER-8522 Motherboard



Figure 5-6: JP2 Clear CMOS Jumper

5.4.3 COM Port Setting Jumper

Jumper Label:	JP4
Jumper Type:	3-pin header
Jumper Settings:	See Table 5-4
Jumper Location:	See Figure 5-7

The JP4 jumper sets the communication protocol used by the second serial communications port (COM 2) as RS-232, RS-422 or RS-485. The COM Port Setting jumper selection options are shown in **Table 5-4**.

JP4	Description	
Short 1-2	RS-232	Default
Short 2-3	RS-422/485	

Table 5-4: COM Port Setting Jumper Settings

The COM Port Setting jumper location is shown in **Figure 5-7** below.



Figure 5-7: COM Port Setting Jumper Location

5.4.4 LCD Voltage Selection



Permanent damage to the screen and WAFER-8522 may occur if the wrong voltage is selected with this jumper. Please refer to the user guide that came with the monitor to select the correct voltage.

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Jumper Label:	JP5
Jumper Type:	3-pin header
Jumper Settings:	See Table 5-5
Jumper Location:	See Figure 5-8

The LCD Voltage Selection jumper allows the LCD screen voltage to be set. The LCD Voltage Selection jumper settings are shown in Table 5-5.

AT Power Select	Description	
Short 1-2	+5V LVDS	
Short 2-3	+3.3V LVDS	Default







The LCD Voltage Selection jumper location is shown in Figure 5-8.



Figure 5-8: LCD Voltage Selection Jumper Location

5.4.5 LCD Resolution Selection

Jumper Label:	JP1
Jumper Type:	8-pin header
Jumper Settings:	See Table 5-6
Jumper Location:	See Figure 5-9

Use the LCD Resolution jumper to select the resolution of the LCD. The LCD Resolution settings are shown in **Table 5-6**.

	PIN	INO.	Description	
7-8	5-6	3-4	1-2	
Open	Open	Open	Open	For BIOS Setting
Open	Open	Open	Short	Type 0: 640x480 18-bit
Open	Open	Short	Open	Type 1: 800x600 18-bit
Open	Open	Short	Short	Type 2: 1024x768 18-bit
Open	Short	Open	Open	Type 3: 1280x1024 48-bit
Open	Short	Open	Short	Type 4: 1400x1050 48-bit

Open	Short	Short	Open	Type 5: 1400x1050 36-bit
open	31011	31011	Open	Type 3: 1400x1030 30-bit
Open	Short	Short	Short	Type 6: 1600x1200 48-bit
Short	Open	Open	Open	Type 7: 1280x768 18-bit
Short	Open	Open	Short	Type 8: 1600x1050 48-bit
Short	Open	Short	Open	Type 9: 1920x1200 36-bit
Short	Open	Short	Short	Type 10: 1024x768 24-bit
Short	Short	Open	Open	Type 11: Reserved
Short	Short	Open	Short	Type 12: Reserved
Short	Short	Short	Open	Type 13: Reserved
Short	Short	Short	Short	Type 14: Reserved

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Table 5-6: LCD Resolution Jumper Settings

The LCD resolution jumper location is shown in **Figure 5-9**.



Figure 5-9: LCD Resolution Jumper Location





5.5 Chassis Installation

5.5.1 Airflow



Airflow is critical to the cooling of the CPU and other onboard components. The chassis in which the WAFER-8522 must have air vents to allow cool air to move into the system and hot air to move out.

The WAFER-8522 must be installed in a chassis with ventilation holes on the sides allowing airflow to travel through the heat sink surface. In a system with an individual power supply unit, the cooling fan of a power supply can also help generate airflow through the board surface.

5.5.2 Motherboard Installation

To install the WAFER-8522 motherboard into the chassis please refer to the reference material that came with the chassis.

5.6 Internal Peripheral Device Connections

5.6.1 Peripheral Device Cables

The cables listed in Table 5-7 are shipped with the WAFER-8522.

Quantity	Туре
1	Audio cable
1	IDE flat cable 44p/44p
1	4 COM port RS-232 cable
1	PS2 Keyboard/Mouse cable

Table 5-7: IEI Provided Cables

5.6.2 ATA Flat Cable Connection

The IDE flat cable connects to the WAFER-8522 to one or two IDE devices. To connect an IDE HDD to the WAFER-8522 please follow the instructions below.

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- Step 1: Locate the IDE connector. The location/s of the IDE device connector/s is/are shown in Chapter 3.
- Step 2: Insert the connector. Connect the IDE cable connector to the onboard connector. See Figure 5-10. A key on the front of the cable connector ensures it can only be inserted in one direction.





Step 3: Connect the cable to an IDE device. Connect the two connectors on the other side of the cable to one or two IDE devices. Make sure that pin 1 on the cable corresponds to pin 1 on the connector.





5.6.3 Audio Kit Installation

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The Audio Kit that came with the WAFER-8522 connects to the 10-pin audio connector on the WAFER-8522. The audio kit consists of three audio jacks. One audio jack, Mic In, connects to a microphone. The remaining two audio jacks, Line-In and Line-Out, connect to two speakers. To install the audio kit, please refer to the steps below:

- Step 1: Locate the audio connector. The location of the 10-pin audio connector is shown in Chapter 3.
- Step 2: Align pin 1. Align pin 1 on the onboard connector with pin 1 on the audio kit connector. Pin 1 on the audio kit connector is indicated with a white dot. See Figure 5-11.



Figure 5-11: IDE Cable Connection

Step 3: Connect the audio devices. Connect one speaker to the line-in audio jack, one speaker to the line-out audio jack and a microphone to the mic-in audio jack.



5.6.4 Keyboard/Mouse Y-cable Connector

The WAFER-8522 is shipped with a keyboard/mouse Y-cable connector. The keyboard/mouse Y-cable connector connects to a keyboard/mouse connector on the WAFER-8522 and branches into two cables that are each connected to a PS/2 connector, one for a mouse and one for a keyboard. To connect the keyboard/mouse Y-cable connector please follow the steps below.

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- Step 1: Locate the connector. The location of the keyboard/mouse Y-cable connector is shown in Chapter 3.
- Step 2: Align the connectors. Correctly align pin 1 on the cable connector with pin 1 on the WAFER-8522 keyboard/mouse connector. See Figure 5-12.
- Step 3: Insert the cable connectors Once the cable connector is properly aligned with the keyboard/mouse connector on the WAFER-8522, connect the cable connector to the onboard connectors. See Figure 5-12.





Figure 5-12: Keyboard/mouse Y-cable Connection

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- Step 4: Attach PS/2 connectors to the chassis. The keyboard/mouse Y-cable connector is connected to two PS/2 connectors. To secure the PS/2 connectors to the chassis please refer to the installation instructions that came with the chassis.
- Step 5: Connect the keyboard and mouse. Once the PS/2 connectors are connected to the chassis, a keyboard and mouse can each be connected to one of the PS/2 connectors. The keyboard PS/2 connector and mouse PS/2 connector are both marked. Please make sure the keyboard and mouse are connected to the correct PS/2 connector.

5.6.5 Four Serial Port Connector Cable

The WAFER-8522 is shipped with one four serial port connector cable. The four serial port connector cable connects four serial port connectors on the cable to the 40-pin serial port connectors on the WAFER-8522. To connect the four serial port connector cable please follow the steps below.

- Step 1: Locate the serial port connector. The location of the 40-pin serial port connector is shown in Chapter 3.
- Step 2: Align the connectors. Correctly align pin 1 on the cable connector with pin 1 on the WAFER-8522 40-pin serial port connector. See Figure 5-12.
- Step 3: Insert the cable connectors Once the cable connector is properly aligned with the 40-pin serial port connector on the WAFER-8522, connect the cable connector to the onboard connectors. See Figure 5-12.



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Figure 5-13: Four Serial Port Connector Cable Connection

Step 4: Attach DB-9 serial port connectors to the chassis. The four DB-9 serial port connectors can be inserted into four preformed holes in the chassis. Once, inserted the DB-9 connectors should be secured to the chassis with the retention screws.

5.7 External Peripheral Interface Connection

The following external peripheral devices can be connected to the external peripheral interface connectors.

- RJ-45 Ethernet cable connectors
- Serial port devices
- USB devices
- VGA monitors

To install these devices, connect the corresponding cable connector from the actual device to the corresponding WAFER-8522 external peripheral interface connector making sure the pins are properly aligned.





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AMI BIOS





6.1 Introduction

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A licensed copy of AMI BIOS is preprogrammed into the ROM BIOS. The BIOS setup program allows users to modify the basic system configuration. This chapter describes how to access the BIOS setup program and the configuration options that may be changed.

6.1.1 Starting Setup

The AMI BIOS is activated when the computer is turned on. The setup program can be activated in one of two ways.

- 1. Press the DELETE key as soon as the system is turned on or
- 2. Press the **DELETE** key when the "**Press Del to enter SETUP**" message appears on the screen.

If the message disappears before the **DELETE** key is pressed, restart the computer and try again.

6.1.2 Using Setup

Use the arrow keys to highlight items, press **ENTER** to select, use the PageUp and PageDown keys to change entries, press **F1** for help and press **Esc** to quit. Navigation keys are shown in.

Кеу	Function
Up arrow	Move to previous item
Down arrow	Move to next item
Left arrow	Move to the item on the left hand side
Right arrow	Move to the item on the right hand side
Esc key	Main Menu – Quit and not save changes into CMOS
	Status Page Setup Menu and Option Page Setup Menu
	Exit current page and return to Main Menu
"+" key	Increase the numeric value or make changes

"-" key	Decrease the numeric value or make changes		
F1 key	General help, only for Status Page Setup Menu and Option		
	Page Setup Menu		
F2 /F3 key	Change color from total 16 colors. F2 to select color		
	forward.		
F10 key	Save all the CMOS changes, only for Main Menu		

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Table 6-1: BIOS Navigation Keys

6.1.3 Getting Help

When **F1** is pressed a small help window describing the appropriate keys to use and the possible selections for the highlighted item appears. To exit the Help Window press **Esc** or the **F1** key again.

6.1.4 Unable to Reboot After Configuration Changes

If the computer cannot boot after changes to the system configuration is made, CMOS defaults. Use the jumper described in **Chapter 5**, **Section 5.4.2**.

6.1.5 BIOS Menu Bar

The menu bar on top of the BIOS screen has the following main items:

- **Main** Changes the basic system configuration.
- Advanced Changes the advanced system settings.
- PCIPnP Changes the advanced PCI/PnP Settings
- **Boot** Changes the system boot configuration.
- Security Sets User and Supervisor Passwords.
- Chipset Changes the chipset settings.
- **Power** Changes power management settings.
- **Exit** Selects exit options and loads default settings

The following sections completely describe the configuration options found in the menu items at the top of the BIOS screen and listed above.







6.2 Main

The **Main** BIOS menu (**BIOS Menu 1**) appears when the **BIOS Setup** program is entered. The **Main** menu gives an overview of the basic system information.

			BIOS SETU	P UTILITY		
Main	Advanced	Boot	Security	Chipset	Po	wer Exit
System	Overview					Use [ENTER], [TAB] or [SHIFT-TAB] to
AMIBIO: Version	S n :08.00.13	}				select a field.
Build I ID	Date:02/28/07 :E084MR11	ł				Use [+] or [-] to configure system Time.
Process Type Speed Count	sor : :255MHz :255					
<mark>System</mark> Size	Memory :504MB					 ← Select Screen ↑↓ Select Item +- Change Field
System System	Time Date		[00:05: [Tue 01.	12] /01/2002]		TabSelect FieldF1General HelpF10Save and ExitESCExit
	v02.59 ((:) Copyr i	ght 1985-200	5, American	Meg	atrends, Inc.

BIOS Menu 1: Main

➔ System Overview

The **System Overview** lists a brief summary of different system components. The fields in **System Overview** cannot be changed. The items shown in the system overview include:

- AMI BIOS: Displays auto-detected BIOS information
 - O Version: Current BIOS version
 - O Build Date: Date the current BIOS version was made
 - O ID: Installed BIOS ID
- Processor: Displays auto-detected CPU specifications

- O Type: Names the currently installed processor
- O Speed: Lists the processor speed
- O Count: The number of CPUs on the motherboard
- System Memory: Displays the auto-detected system memory.

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O Size: Lists memory size

The System Overview field also has two user configurable fields:

→ System Time [xx:xx:xx]

Use the **System Time** option to set the system time. Manually enter the hours, minutes and seconds.

→ System Date [xx/xx/xx]

Use the **System Date** option to set the system date. Manually enter the day, month and year.

6.3 Advanced

Use the **Advanced** menu (**BIOS Menu 2**) to configure the CPU and peripheral devices through the following sub-menus:



Setting the wrong values in the sections below may cause the system to malfunction. Make sure that the settings made are compatible with the hardware.

- CPU Configuration (see Section 6.3.1)
- IDE Configuration (see **Section 6.3.2**)
- SuperIO Configuration (see Section 6.3.3)
- Hardware Health Configuration (see Section 0)
- MPS Configuration (see Section 6.3.5)





Trusted Computing (see **Section 0**)

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USB Configuration (see Section 6.3.7)

			BIOS SETU	P UTILITY			
Main	Advanced	Boot	Security	Chipset	Pow	er	Exit
Advanc WARNIN CPU IDE Supe Hard ACPI MPS Trus USB	ed Settings G: Setting wi may cause Configuration Configuration rID Configuration Ware Health (Configuration ted Computing Configuration ted Computing	rong val system n ation Configur on n g	ues in below to malfuncti ation	sections on.		¢ Conf ↑↓ Ente F1 F10 ESC	Select Screen Select Item r Go to Sub Screen General Help Save and Exit Exit
	v02.59 (C) Copyr i	ght 1985-200	5, Americar	n Mega	tren	ds, Inc.

BIOS Menu 2: Advanced

6.3.1 CPU Configuration

Use the CPU Configuration menu (**BIOS Menu 3**) to view detailed CPU specifications and configure the CPU.



BIOS SETUP UTILITY Advanced		
Configure advanced CPU settings Module Version -13.04	When disabled, force the XD feature flag to	
Manufacturer:Intel Brand String: Frequency :255MHz FSB Speed :127MHz	aiways return 0.	
Cache L1 :0 KB Cache L2 :0 KB		
Ratio Status :Unlocked (Max:80, Min:08) Ratio Actual Value:8	← Select Screen	
Execute Disable Bit [Enabled]	+- Change Option F1 General Helm	
Intel(R) SpeedStep(tm) tech. [Disabled]	F10 Save and Exit ESC Exit	
u02 59 (C)Comunight 1985-2005 American Mer	vatrende. Inc	

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BIOS Menu 3: CPU Configuration

The CPU Configuration menu (BIOS Menu 3) lists the following CPU details:

- **Manufacturer**: Lists the name of the CPU manufacturer
- Brand String: Lists the brand name of the CPU being used
- Frequency: Lists the CPU processing speed
- FSB Speed: Lists the FSB speed
- Cache L1: Lists the CPU L1 cache size
- Cache L2: Lists the CPU L2 cache size

The following **CPU Configuration** menu item can be configured.

- Execute Disable Bit
- Intel® SpeedStep[™] tech

→ Execute Bit Disable [Enabled]





Use the **Execute Bit Disable** BIOS function to protect the system from buffer overflow attacks.

→	Disabled		Code can be executed in any memory area.
→	Enabled	DEFAULT	Code execution in data-only memory pages is
			prohibited.

6.3.2 IDE Configuration

Use the **IDE Configuration** menu (**BIOS Menu 4**) to change and/or set the configuration of the IDE devices installed in the system.

B	IOS SETUP UTILITY	
Advanced		
IDE Configuration		DISABLED: disables the
OnBoard PCI IDE Controller OnBoard PCI IDE Operate Mode	[Both] [Legacy Mode]	Controller. PRIMARY: enables only the Primary IDE
 Primary IDE Master Primary IDE Slave Secondary IDE Master Secondary IDE Slave 	: [Not Detected] : [Not Detected] : [Not Detected] : [Not Detected]	Controller. SECONDARY: enables only the Secondary IDE Controller.
Hard Disk Write Protect IDE Detect Time Out (Sec) ATA(PI) 80Pin Cable Detection	[Disabled] [35] [Host & Device]	BUTH: enables both IDE Controllers. • Select Screen †↓ Select Item •- Change Option F1 General Help F10 Save and Exit ESC Exit
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BIOS Menu 4: IDE Configuration

→ OnBoard PCI IDE Controller [Both]

Use the **OnBoard PCI IDE Controller** BIOS option to specify the IDE channels used by the onboard PCI IDE controller. The following configuration options are available.

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→	Disabled		Prevents the system from using the onboard IDE
			controller
→	Primary		Only allows the system to detect the Primary IDE
			channel, including both the Primary Master and the
			Primary Slave
→	Secondary		Only allows the system to detect the Secondary IDE
			channel, including both the Secondary Master and
			Secondary Slave
→	Both	DEFAULT	Allows the system to detect both the Primary and
			Secondary IDE channels including the Primary Master,
			Primary Slave, Secondary Master and Secondary
			Slave.

→ Onboard PCI IDE Operate Mode [Legacy Mode]

Use the **Onboard PCI IDE Operate Mode** BIOS option to set the running mode for the PCI IDE.

Legacy Mode DEFAULT The PCI IDE mode is the same as the IDE mode
 Native Mode The PCI IDE mode is the native mode

→ Hard Disk Write Protect [Disabled]

The **Hard Disk Write Protect** BIOS option protects the hard disks from being overwritten. This menu item is only effective if the device is accessed through the BIOS.

Disabled DEFAULT Allows hard disks to be overwritten





- → Enabled
- Prevents hard disks from being overwritten

→ IDE Detect Time Out (Sec) [35]

The **IDE Detect Time Out (Sec)** BIOS option specifies the maximum time (in seconds) the AMI BIOS will search for IDE devices. This allows fine-tunes the settings to allow for faster boot times. The following configuration options are available.

- 0 seconds
- 5 seconds
- 10 seconds
- 15 seconds
- 20 seconds
- 25 seconds
- 30 seconds
- 35 seconds (Default)

The best setting to use if the onboard IDE controllers are set to a specific IDE disk drive in the AMI BIOS is "0 seconds" and a large majority of ultra ATA hard disk drives can be detected well within "35 seconds" (the default setting).

→ ATA (PI) 80Pin Cable Detection [Host & Device]

When an Ultra ATA/66, an Ultra ATA/100 or an Ultra ATA/133 IDE hard disk drive is used, an 80-conductor ATA cable must be used. The 80-conductor ATA cable is plug compatible with the standard 40-conductor ATA cable. The system must detect the presence of correct cable so that the AMIBIOS can instruct the drive to run at the correct speed for the cable type detected.

The ATA (PI) 80Pin Cable Detection BIOS option determines how the IDE cable will be detected.



→	Host & Device	DEFAULT	Both the motherboard onboard IDE controller and
			IDE disk drive are used to detect the type of IDE
			cable used.
→	Host		The motherboard onboard IDE controller detects the type of IDE cable used.
→	Device		The IDE disk drive to detects the type of IDE cable

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→ IDE Master and IDE Slave

When entering setup, BIOS auto detects the presence of IDE devices. BIOS displays the status of the auto detected IDE devices. The following IDE devices are detected and are shown in the **IDE Configuration** menu:

- Primary IDE Master
- Primary IDE Slave
- Secondary IDE Master
- Secondary IDE Slave

The **IDE Configuration** menu (**BIOS Menu 4**) allows changes to the configurations for the IDE devices installed in the system. If an IDE device is detected, and one of the above listed four BIOS configuration options are selected, the IDE configuration options shown in **Section 6.3.2.1** appear.

6.3.2.1 IDE Master, IDE Slave

Use the **IDE Master** and **IDE Slave** configuration menu to view both primary and secondary IDE device details and configure the IDE devices connected to the system.



Primary IDE Master		Seleo	Select the type	
Device :Not Detected Type [Auto] LBA/Large Mode [Auto] Block (Multi-Sector Transfer) [Auto] PID Mode [Auto]		<pre>of device connected to the system.</pre>		
DMA Mode S.M.A.R.T. 32Bit Data Transfer	[Auto] [Auto] [Enabled]			
		←→ ↑↓ +- F1 F10 ESC	Select Screen Select Item Change Option General Help Save and Exit Exit	



→ Auto-Detected Drive Parameters

Page 94

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The "grayed-out" items in the left frame are IDE disk drive parameters automatically detected from the firmware of the selected IDE disk drive. The drive parameters are listed as follows:

- **Type**: Lists the device type (e.g. hard disk, CD-ROM etc.)
- LBA Mode: Indicates whether the LBA (Logical Block Addressing) is a method of addressing data on a disk drive is supported or not.
- Block Mode: Block mode boosts IDE drive performance by increasing the amount of data transferred. Only 512 bytes of data can be transferred per interrupt if block mode is not used. Block mode allows transfers of up to 64 KB per interrupt.
- PIO Mode: Indicates the PIO mode of the installed device.
- DMA Mode: Indicates the highest Asynchronous DMA Mode that is supported.
S.M.A.R.T.: Indicates whether or not the Self-Monitoring Analysis and Reporting Technology protocol is supported.

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➔ Type [Auto]

Use the **Type** BIOS option select the type of device the AMIBIOS attempts to boot from after the Power-On Self-Test (POST) is complete.

→	Not Installed		BIOS is prevented from searching for an IDE disk
→	Auto		drive on the specified channel.
	Auto	DEFAULT	attached to the specified channel. This setting should
			be used if an IDE hard disk drive is attached to the
→			specified channel.
	CD/DVD		drive is attached to the specified IDE channel. The
			BIOS does not attempt to search for other types of
→			IDE disk drives on the specified channel.
	ARMD		Device. These include, but are not limited to:
			→ ZIP
			→ LS-120

→ LBA/Large Mode [Auto]

→

Use the **LBA/Large Mode** option to disable or enable BIOS to auto detects LBA (Logical Block Addressing). LBA is a method of addressing data on a disk drive. In LBA mode, the maximum drive capacity is 137 GB.

Disabled BIOS is prevented from using the LBA mode control on



the specified channel.

Auto DEFAULT BIOS auto detects the LBA mode control on the specified channel.

→ Block (Multi Sector Transfer) [Auto]

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Use the **Block (Multi Sector Transfer)** to disable or enable BIOS to auto detect if the device supports multi-sector transfers.

→	Disabled		BIOS is prevented from using Multi-Sector Transfer on the
			specified channel. The data to and from the device occurs
			one sector at a time.
→	Auto	DEFAULT	BIOS auto detects Multi-Sector Transfer support on the
			drive on the specified channel. If supported the data

transfer to and from the device occurs multiple sectors at a time.

→ PIO Mode [Auto]

Use the **PIO Mode** option to select the IDE PIO (Programmable I/O) mode program timing cycles between the IDE drive and the programmable IDE controller. As the PIO mode increases, the cycle time decreases.

→	Auto	DEFAULT	BIOS auto detects the PIO mode. Use this value if the IDE disk
			drive support cannot be determined.
→	0		PIO mode 0 selected with a maximum transfer rate of 3.3MBps
→	1		PIO mode 1 selected with a maximum transfer rate of 5.2MBps
→	2		PIO mode 2 selected with a maximum transfer rate of 8.3MBps
→	3		PIO mode 3 selected with a maximum transfer rate of 11.1MBps

Page 96

4

PIO mode 4 selected with a maximum transfer rate of 16.6MBps (This setting generally works with all hard disk drives manufactured after 1999. For other disk drives, such as IDE CD-ROM drives, check the specifications of the drive.)

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➔ DMA Mode [Auto]

Use the DMA Mode BIOS selection to adjust the DMA mode options.

Auto DEFAULT BIOS auto detects the DMA mode. Use this value if the IDE disk drive support cannot be determined.

➔ S.M.A.R.T [Auto]

Use the **S.M.A.R.T** option to auto-detect, disable or enable Self-Monitoring Analysis and Reporting Technology (SMART) on the drive on the specified channel. **S.M.A.R.T** predicts impending drive failures. The **S.M.A.R.T** BIOS option enables or disables this function.

→	Auto	DEFAULT	BIOS auto detects HDD SMART support.
→	Disabled		Prevents BIOS from using the HDD SMART feature.
→	Enabled		Allows BIOS to use the HDD SMART feature

→ 32Bit Data Transfer [Disabled]

Use the **32Bit Data Transfer** BIOS option to enables or disable 32-bit data transfers.

→	Disabled	DEFAULT	Prevents the BIOS from using 32-bit data transfers.
→	Enabled		Allows BIOS to use 32-bit data transfers on supported
			hard disk drives.

6.3.3 Super IO Configuration



Use the **Super IO Configuration** menu (**BIOS Menu 6**) to set or change the configurations for the FDD controllers, parallel ports and serial ports.

Advanced	BIOS SETUP UTILITY	
Configure ITE8712 Super IO (Chipset	Allows BIOS to Select — Serial Port1 Base
Serial Port1 Address Serial Port2 Address Serial Port2 Address Serial Port2 Mode Restore on AC Power Loss Serial Port3 Address Serial Port3 IRQ Serial Port4 Address Serial Port5 Address Serial Port5 IRQ Serial Port6 Address Serial Port6 IRQ	[3F8/TRQ4] [Normal] [2F8/TRQ3] [Normal] [Power On] [3E8] [11] [2E8] [10] [2F0] [11] [2E0] [10]	Addresses. • Select Screen 14 Select Item +- Change Option F1 General Help F10 Save and Exit ESC Exit
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BIOS Menu 6: Super IO Configuration

→ Serial Port1 Address [3F8/IRQ4]

Page 98

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Use the Serial Port1 Address option to select the Serial Port 1 base address.

→	Disabled		No base address is assigned to Serial Port 1
→	3F8/IRQ4	DEFAULT	Serial Port 1 I/O port address is 3F8 and the interrupt address is IRQ4
→	3E8/IRQ4		Serial Port 1 I/O port address is 3E8 and the interrupt address is IRQ4
→	2E8/IRQ3		Serial Port 1 I/O port address is 2E8 and the interrupt address is IRQ3

→ Serial Port1 Mode [Normal]

Use the **Serial Port1 Mode** option to select the transmitting and receiving mode for the first serial port.

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→	Normal	(Default)	Serial Port 1 mode is normal
→	IrDA		Serial Port 1 mode is IrDA
→	ASK IR		Serial Port 1 mode is ASK IR

→ Serial Port2 Address [2F8/IRQ3]

Use the Serial Port2 Address option to select the Serial Port 2 base address.

→	Disabled		No base address is assigned to Serial Port 2
→	2F8/IRQ3	DEFAULT	Serial Port 2 I/O port address is 3F8 and the interrupt
→	3E8/IRQ4		Serial Port 2 I/O port address is 3E8 and the interrupt address is IRQ4
→	2E8/IRQ3		Serial Port 2 I/O port address is 2E8 and the interrupt address is IRQ3

→ Serial Port2 Mode [Normal]

Use the **Serial Port2 Mode** option to select the Serial Port2 operational mode.

→	Normal	DEFAULT	Serial Port 2 mode is normal
→	IrDA		Serial Port 2 mode is IrDA
→	ASK IR		Serial Port 2 mode is ASK IR

→ Restore on AC Power Loss [Power On]



The Restore on AC Power Loss BIOS option specifies what state the system returns to if there is a sudden loss of power to the system.

→	Power Off		The system remains turned off
→	Power On	DEFAULT	The system turns on
→	Last State		The system returns to its previous state. If it was on, it
			turns itself on. If it was off, it remains off.

→ Serial Port3 Address [3E8]

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Use the Serial Port3 Address option to select the base addresses for serial port 3

→	Disabled		No base address is assigned to serial port 3
→	3E8	DEFAULT	Serial port 3 I/O port address is 3E8
→	2F8		Serial port 3 I/O port address is 2F8
→	3E8		Serial port 3 I/O port address is 3E8
→	2E8		Serial port 3 I/O port address is 2E8
→	2F0		Serial port 3 I/O port address is 2F0
→	2E0		Serial port 3 I/O port address is 2E0

→ Serial Port3 IRQ [11]

Page 100

Use the Serial Port3 IRQ option to select the interrupt address for serial port 3.

→	4		Serial port 3 IRQ address is 4
→	9		Serial port 3 IRQ address is 9
→	10		Serial port 3 IRQ address is 10
→	11	DEFAULT	Serial port 3 IRQ address is 11

→ Serial Port4 Address [2E8]

Use the Serial Port4 IRQ option to select the interrupt address for serial port 4.

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→	Disabled		No base address is assigned to serial port 3
→	3F8		Serial port 4 I/O port address is 3F8
→	2F8		Serial port 4 I/O port address is 2F8
→	3E8		Serial port 4 I/O port address is 3E8
→	2E8	DEFAULT	Serial port 4 I/O port address is 2E8
→	2F0		Serial port 4 I/O port address is 2F0
→	2E0		Serial port 4 I/O port address is 2E0

→ Serial Port4 IRQ [10]

Use the Serial Port4 IRQ option to select the interrupt address for serial port 4.

→	3		Serial port 4 IRQ address is 3
→	9		Serial port 4 IRQ address is 9
→	10	DEFAULT	Serial port 4 IRQ address is 10
→	11		Serial port 4 IRQ address is 11

→ Serial Port5 Address [2F0]

Use the Serial Port5 IRQ option to select the interrupt address for serial port 5.

→	Disabled		No base address is assigned to serial port 3
→	3E8		Serial port 5 I/O port address is 3E8
→	2E8		Serial port 5 I/O port address is 2E8
→	2F0	DEFAULT	Serial port 5 I/O port address is 2F0



→	2E0	Serial port 5 I/O port address is 2E0
→	2D8	Serial port 5 I/O port address is 2D8
→	2D0	Serial port 5 I/O port address is 2D0

→ Serial Port5 IRQ [11]

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Use the Serial Port5 IRQ option to select the interrupt address for serial port 5.

→	3		Serial port 4 IRQ address is 3
→	9		Serial port 4 IRQ address is 9
→	10		Serial port 4 IRQ address is 10
→	11	DEFAULT	Serial port 4 IRQ address is 11

→ Serial Port6 Address [2E0]

Use the Serial Port6 IRQ option to select the interrupt address for serial port6.

→	Disabled		No base address is assigned to serial port 3
→	3E8		Serial port 6 I/O port address is 3E8
→	2E8		Serial port 6 I/O port address is 2E8
→	2F0		Serial port 6 I/O port address is 2F0
→	2E0	DEFAULT	Serial port 6 I/O port address is 2E0
→	2D8		Serial port 6 I/O port address is 2D8
→	2D0		Serial port 6 I/O port address is 2D0

→ Serial Port6 IRQ [10]

Page 102

Use the Serial Port6 IRQ option to select the interrupt address for serial port 6.

→	3		Serial port 6 IRQ address is 3
→	9		Serial port 6 IRQ address is 9
→	10	DEFAULT	Serial port 6 IRQ address is 10
→	11		Serial port 6 IRQ address is 11

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6.3.4 Hardware Health Configuration

The **Hardware Health Configuration** menu (**BIOS Menu 7**) shows the operating temperature, fan speeds and system voltages.

Aduanced	BIOS SETUP UTILITY			
Hardware Health Configura	ation	Enables Hardware		
H/W Health Function	[Enabled]	Device.		
Temperature Sensor #2	:54°C/129°F			
CPU Core Vcc +3 30U	:0.944 V :2.496 V :3.344 U			
+5.00V +1.5V	:4.596 V :1.392 V	← Select Screen		
VBAT	:3.088 V	↑↓ Select Item +- Change Option F1 Compute Holm		
		F1 General help F10 Save and Exit ESC Exit		
v02.59 (C)Copyright 1985-2005, American Megatrends, Inc.				

BIOS Menu 7: Hardware Health Configuration

The following system parameters and values are shown. The system parameters that are monitored are:

- System Temperatures: The following system temperatures are monitored
 - O Temperature Sensor #1
 - O Temperature Sensor #2
- Voltages: The following system voltages are monitored
 - O CPU Core
 - O VCC
 - O +3.3V

Page 104

0	+5.0V
0	+1.5V

O VBAT

6.3.5 MPS Configuration

Use the MPS Configuration menu (BIOS Menu 8) to select `he multi-processor table.

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Advanced	BIOS SETUP UTILITY	
MPS Configuration	1	Select MPS
MPS Revision	[1.1]	 ← Select Screen ↑↓ Select Item +- Change Option F1 General Help F10 Save and Exit ESC Exit
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BIOS Menu 8: MPS Configuration

→ MPS Revision [1.1]

Use the **Multiprocessor Specification (MPS) for OS** option to specify the MPS version to be used.

1.1 DEFAULT MPS version 1.1 is used

1.4 MPS version 1.4 is used





6.3.6 Trusted Computing

Use the Trusted Computing menu (BIOS Menu 9) to configure TPM parameters.

	BIOS SETUP UTILITY	
Advanced		
Trusted Computing TPM Device	(Disable)	Enable/Disable TPM device
		 Select Screen Select Item Change Option General Help Save and Exit ESC Exit
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BIOS Menu 9: Trusted Computing

→ TPM Device [Disabled]

Use the **TPM Device** to disable or enable the system to support the Trusted Platform Module (TPM).



→ Enabled TPM function supported

6.3.7 USB Configuration



Use the **USB Configuration** menu (**BIOS Menu 10**) to read USB configuration information and configure the USB settings.

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BIOS SETUP UTIL	ITY
Advanced	
USB Configuration	Enables USB host
Module Version - 2.24.0-11.4	
USB Devices Enabled : 1 Drive	
USB FunctionI4 USB Ports]Legacy USB Support[Enabled]USB 2.0 Controller[Enabled]USB 2.0 Controller Mode[FullSpeed]	
▶ USB Mass Storage Device Configuration	 Select Screen Select Item Change Option General Help Save and Exit ESC Exit
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BIOS Menu 10: USB Configuration

→ USB Configuration

The USB Configuration field shows the system USB configuration. The items listed are:

■ Module Version: 2.24.0-11.4

→ USB Devices Enabled

The USB Devices Enabled field lists the USB devices that are enabled on the system

→ USB Function [4 USB Ports]

Use the **USB Function** BIOS option to enable USB host controllers.



→	Disabled		USB function support disabled
→	2 USB Ports		The USB controller activates 2 USB ports
→	4 USB Ports	DEFAULT	The USB controller activates 4 USB ports

→ Legacy USB Support [Enabled]

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Use the Legacy USB Support BIOS option to enable USB mouse and USB keyboard support.

Normally if this option is not enabled, any attached USB mouse or USB keyboard does not become available until a USB compatible operating system is fully booted with all USB drivers loaded. When this option is enabled, any attached USB mouse or USB keyboard can control the system even when there is no USB driver loaded onto the system.

→	Disabled		Legacy USB support disabled
→	Enabled	DEFAULT	Legacy USB support enabled
→	Auto		The Legacy USB support is automatically detected
			and enabled.

→ USB 2.0 Controller [Enabled]

Use the USB 2.0 Controller BIOS option to enable or disable the USB 2.0 controller

→	Enabled	DEFAULT	USB 2.0 controller enabled
→	Disabled		USB 2.0 controller disabled

→ USB2.0 Controller Mode [FullSpeed]

Use the **USB2.0 Controller Mode** option to set the speed of the USB2.0 controller.

→	FullSpeed	DEFAULT	The controller is capable of operating at 12Mb/s
→	HiSpeed		The controller is capable of operating at 480Mb/s

Page 108

6.3.7.1 USB Mass Storage Device Configuration

Use the USB Mass Storage Device Configuration menu (BIOS Menu 11) to configure USB mass storage class devices.

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BIOS SETUP UTILITY Advanced		
USB Mass Storage Device Configuration	Number of seconds	
USB Mass Storage Reset Delay [20 Sec]	USB mass storage	
Device #1 JetFlash TS1GJF110 Emulation Type [Auto]	unit command.	
	← Select Screen	
	+- Change Option F1 General Helm	
	F10 Save and Exit ESC Exit	
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BIOS Menu 11: USB Mass Storage Device Configuration

→ Device

The **Device##** field lists the USB devices that are connected to the system.

→ Emulation Type [Auto]

Use the **Emulation Type** BIOS option to specify the type of emulation BIOS has to provide for the USB device.







Please note that the device's formatted type and the emulation type provided by the BIOS must match for a device to boot properly. If both types do not match then device's behavior is undefined. To make sure both types match, format the device using BIOS INT13h calls after selecting the proper emulation option in BIOS setup. The FORMAT utility provided by Microsoft® MS-DOS®, Microsoft® Windows® 95, and Microsoft® Windows® 98 can be used for this purpose.

→	Auto	DEFAULT	BIOS auto-detects the current USB.
→	Floppy		The USB device will be emulated as a floppy drive. The device can be either A: or B: responding to INT13h calls that return $DL = 0$ or $DL = 1$ respectively.
→	Forced FDD		Allows a hard disk image to be connected as a floppy image. This option works only for drives formatted with FAT12, FAT16 or FAT32.
→	Hard Disk		Allows the USB device to be emulated as hard disk responding to INT13h calls that return DL values of 80h or above.
→	CDROM		Assumes the CD-ROM is formatted as bootable media. All the devices that support block sizes greater than 512 bytes can only be booted using this option.

6.4 Boot

Page 110

Use the Boot menu (BIOS Menu 12) to configure system boot options.

			BIOS SE	TUP UTILITY				
Main	Advanced	PCIPnP	Boot	Security	Ch	ipset	Power	Exit
Boot S > Boot > Boot > Remo	ettings Settings Co Device Prio vable Drives	nfiguratio rity)11)11			Confi durin turin t↓ Enter F1 F10 ESC	gure Sett g System Select Sc Select I Go to Su General Save and Exit	reen tem b Screen Help Exit
	v02.59 (C) Copyr igł	n t 1985-2	005, American	n Meg	gatrend	s, Inc.	

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BIOS Menu 12: Boot

6.4.1 Boot Settings Configuration

Use the Boot Settings Configuration menu (**BIOS Menu 13**) to configure advanced system boot options.



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WAFER-8522 Motherboard

	BIOS SETUP UTILITY	
Boot		
Boot Settings Configuration	Allows BIOS to skip	
Quick Boot Quiet Boot	[Enabled] [Disabled]	booting. This will decrease the time
Boot Display Device	[Auto]	system.
Spread Spectrum Mode	[Disabled]	
		 ← Select Screen ↑↓ Select Item ← Change Option F1 General Help F10 Save and Exit ESC Exit
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BIOS Menu 13: Boot Settings Configuration

→ Quick Boot [Enabled]

Use the Quick Boot BIOS option to make the computer speed up the boot process.

Disabled No POST procedures are skipped
 Enabled DEFAULT Some POST procedures are skipped to decrease the system boot time

→ Quiet Boot [Disabled]

Page 112

Use the Quiet Boot BIOS option to select the screen display when the system boots.

→	Disabled	DEFAULT	Normal POST messages displayed
→	Enabled		OEM Logo displayed instead of POST messages

➔ Boot Display Device [Auto]

The **Boot Display Device** BIOS option selects the display device the system uses when it boots. The available options are listed below:

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- Auto **DEFAULT**
- CRT
- LFP
- CRT + LFP

→ Spread Spectrum Mode [Disabled]

Use the **Spread Spectrum Mode** option to reduce the EMI. Excess EMI is generated when the system clock generator pulses have extreme values. Spreading the pulse spectrum modulates changes in the extreme values from spikes to flat curves, thus reducing the EMI. This benefit may in some cases be outweighed by problems with timing-critical devices, such as a clock-sensitive SCSI device.



6.4.2 Boot Device Priority

Use the **Boot Device Priority** menu (**BIOS Menu 14**) to specify the boot sequence from the available devices. Possible boot devices may include:

HDD



Boot	BIOS SETUP UTILITY	
Boot Device Priority	Specifies the boot	
1st Boot Device	[USB:JetFlash TS1GJ]	A device enclosed in parenthesis has been disabled in the
		 corresponding type menu. ← Select Screen ↑↓ Select Item ↑− Change Option F1 General Help F10 Save and Exit ESC Exit
u02 59 (C) Comuni	ight 1985-2005 American Me	astronde Inc

BIOS Menu 14: Boot Device Priority Settings

6.4.3 Removable Drives

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Use the **Removable Drives** menu (**BIOS Menu 15**) to specify the boot sequence of the available drives. When the menu is opened, the removable drives connected to the system are listed as shown below:

■ 1st Drive [1st USB]



Page 114

Only the drives connected to the system are shown. For example, if only one USB is connected only "**1st Drive**" is listed.

The boot sequence from the available devices is selected. If the "**1st Drive**" option is selected a list of available drives is shown. Select the first drive the system boots from. If the "**1st Drive**" is not used for booting this option may be disabled.

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	BIOS	SETUP UTILITY	
	Boot		
Removable Drives			Specifies the boot
1st Drive	CU:	SB:JetFlash TS1GJ]	available devices.
			 ← Select Screen ↑↓ Select Item ← Change Option F1 General Help F10 Save and Exit ESC Exit
v02.59	(C) Copyright 198	5-2005, American Me	gatrends, Inc.

BIOS Menu 15: Removable Drives

6.5 Security

Use the Security menu (BIOS Menu 16) to set system and user passwords.



		BIOS SETUP	UTILITY	
Main Advanced	Boot S	ecur i ty	Chipset	Power Exit
Security Settings				Install or Change the password.
Supervisor Password User Password	Not Inst Not Inst	alled alled		
Change Supervisor F Change User Passwor Clear User Password	assword d			
				 ← Select Screen ↑↓ Select Item Enter Change F1 General Helm
				F10 Save and Exit ESC Exit
v02.59 (C) Copyr ight	1985-2005	, American I	legatrends, Inc.

BIOS Menu 16: Security

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→ Change Supervisor Password

Use the **Change Supervisor Password** to set or change a supervisor password. The default for this option is **Not Installed**. If a supervisor password must be installed, select this field and enter the password. After the password has been added, **Install** appears next to **Change Supervisor Password**.

→ Change User Password

Use the **Change User Password** to set or change a user password. The default for this option is **Not Installed**. If a user password must be installed, select this field and enter the password. After the password has been added, **Install** appears next to **Change User Password**.

➔ Clear User Password

Page 116



6.6 Chipset

Use the **Chipset** menu (**BIOS Menu 17**) to access the NorthBridge and SouthBridge configuration menus

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Setting the wrong values for the Chipset BIOS selections in the Chipset BIOS menu may cause the system to malfunction.



BIOS Menu 17: Chipset

6.6.1 NorthBridge Configuration





Use the NorthBridge Configuration menu (**BIOS Menu 18**) to configure the northbridge chipset.

NorthBridge Chipset Configuration Configuratio				
DRAM Frequency Configure DRAM Timing by SPD Memory Hole Init. Graphic Adapter Priority Internal Graphics Mode Select Graphics Aperture Size	[Auto] [Enabled] [Disabled] [PCI/Int-UGA] [Enabled, 8MB] [64MB]	Options 200 Mhz 266 Mhz 333 Mhz Auto		
Video Function Configuration Boot Display Device Flat Panel Type Local Flat Panel Scaling	[Auto] [1280x1024] [Auto]	 ← Select Screen ↑↓ Select Item ← Change Option F1 General Help F10 Save and Exit ESC Exit 		

BIOS Menu 18:NorthBridge Chipset Configuration

→ DRAM Frequency [Auto]

Page 118

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Use the **DRAM Frequency** option to specify the DRAM frequency or allow the system to automatically detect the DRAM frequency.

→	200MHz		Sets the DRAM frequency to 200MHz
→	266MHz		Sets the DRAM frequency to 266MHz
→	333MHz		Sets the DRAM frequency to 333MHz
→	Auto	DEFAULT	Automatically selects the DRAM frequency

→ Configure DRAM Timing by SPD [Enabled]

Use the **Configure DRAM Timing by SPD** option to determine if the system uses the SPD (Serial Presence Detect) EEPROM to configure the DRAM timing. The SPD EEPROM contains all necessary DIMM specifications including the speed of the individual components such as CAS and bank cycle time as well as valid settings for the module and the manufacturer's code. The SPD enables the BIOS to read the spec sheet of the DIMMs on boot-up and then adjust the memory timing parameters accordingly.

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Disabled DRAM timing parameters are manually set using the DRAM sub-items
 Enabled DEFAULT DRAM timing parameter are set according to the DRAM Serial Presence Detect (SPD)

If the **Configure DRAM Timing by SPD** option is disabled, the following configuration options appear.

- DRAM CAS# Latency [3]
- DRAM RAS# to CAS# Delay [5 DRAM Clocks]
- DRAM RAS# Precharge [5 DRAM Clocks]
- DRAM RAS# Activate to Precha [15 DRAM Clocks]

➔ Memory Hole [Disabled]

Use the **Memory Hole** option to reserve memory space between 15MB and 16MB for ISA expansion cards that require a specified area of memory to work properly. If an older ISA expansion card is used, please refer to the documentation that came with the card to see if it is necessary to reserve the space.

→	Disabled DEFAULT		Memory is not reserved for ISA expansion cards
→	15MB – 16MB		Between 15MB and 16MB of memory is reserved for
			ISA expansion cards

➔ Init. Graphic Adapter Priority [PCI/Int-VGA]





The **Init. Graphic Adapter Priority** option selects the graphics controller the system uses as a primary boot device. The options are:

- Internal VGA
- PCI/Int-VGA **DEFAULT**

→ Internal Graphics Mode Select [Enable, 8MB]

Use the **Internal Graphic Mode Select** option to specify the amount of system memory that can be used by the Internal graphics device.

→	Disable		
→	Enable, 1MB		1MB of memory used by internal graphics device
→	Enable, 4MB		4MB of memory used by internal graphics device
→	Enable, 8MB	DEFAULT	8MB of memory used by internal graphics device
→	Enable, 16MB		16MB of memory used by internal graphics device
→	Enable, 32MB		32MB of memory used by internal graphics device

→ Graphics Aperture Size [64MB]

The **Graphics Aperture Size** option selects the size of the AGP aperture. The aperture is a portion of the PCI memory address range dedicated as graphics memory address space.

→	64MB	DEFAULT	Graphics aperture size set as 64MB
→	128MB		Graphics aperture size set as 128MB
→	256MB		Graphics aperture size set as 256MB

➔ Boot Display Device [Auto]

The **Boot Display Device** BIOS option selects the display device the system uses when it boots. The available options are listed below:



- Auto **DEFAULT**
- CRT
- LFP
- CRT+LFP

→ Flat Panel Type [1280x1024]

The Flat Panel Type BIOS option specifies the flat panel PC type being used.



Please refer to the technical documents that came with the flat panel PC to ensure the correct settings are selected.

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The following options are available:

- 640x480
- 800x600
- 1024x768
- 1280x1024
- 1400x1050
- 1600x1200
- 1400x900 36bits
- 1440x900 48bits
- 1280x800
- 1024x768 24bit
- 1024x768 48bit

→ Local Flat Panel Scaling [Auto]

The Local Flat Panel Scaling option selects the mode of the local flat panel scaling.

→ Auto DEFAULT Automatically scale the connected local flat



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panel.



Disabled

The connected local flat panel is forced to scale.

Disable the local flat panel scaling.



6.6.2 SouthBridge Configuration

The SouthBridge Intel ICH4 Configuration menu (**BIOS Menu 19**) the southbridge chipset to be configured.

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OnBoard AC'97 Audio Onboard Lan RomIAutol IDisabledlEnable/Disable OnBoard AC'97 Audio.* Select Screen 14 Select Item +- Change Option F1 General Help F10 Save and Exit ESC Exit*		South Bridge Chipset Configurat Chipset	ion
F10 Save and Exit ESC Exit	OnBoard AC'97 Audio Onboard Lan Rom	[Auto] [Disabled]	Enable/Disable OnBoard AC'97 Audio. ← Select Screen ↑↓ Select Item ← Change Option F1 General Help
			FI General Help F10 Save and Exit ESC Exit

BIOS Menu 19:SouthBridge Chipset Configuration

➔ OnBoard AC97 Audio [Auto]

The OnBoard AC97 Audio DEVICE option enables or disables the AC'97 CODEC.

- Auto **DEFAULT** The onboard AC'97 automatically detected and enabled
- Disabled
 The onboard AC'97 is disabled

➔ OnBoard Lan Rom [Disabled]

The **OnBoard Lan Rom** option enables or disables the onboard LAN.





6.7 Power Key

The **Power** menu (**BIOS Menu 20**) allows the advanced power management options to be configured.

			BIOS SETU	P UTILITY		
Main Ad	vanced	Boot	Security	Chipset	Power	Exit
APM Config	uration					Options
Power Type Resume On Resume On Power Butt	Select Ring PME# on Mode		IAT] [Disable [Enable [On/Off]	ed] 11 1	AT ATX	
					+ ++ F1	Select Screen Select Item Change Option General Help
					F10 ESC	Save and Exit Exit
	v02.59 ((C) Copyr ig	ht 1985-200	5, American	Megatre	nds, Inc.

BIOS Menu 20:Power

➔ Power Type Select [AT]

→

Use the **Power Type Select** BIOS option to select the power supply that is connected to the system.

AT DEFAULT An AT power supply is connected to the system





An ATX power supply is connected to the system

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→ Resume on Ring [Disabled]

The **Resume on Ring** BIOS option specifies if the system will be roused from a suspended or standby state when there is activity on the RI (ring in) modem line. That is, the system will be roused by an incoming call on a modem.

→	Disabled DEFAULT		Wake event not generated by an incoming ca				
→	Enabled		Wake event generated by an incoming call				

➔ Resume on PME# [Enabled]

The **Resume on PME#** BIOS option specifies if the system will be roused from a suspended or standby state when there is activity on the PCI PME (power management event) controller.



Enabled DEFAULT Wake event generated by PCI PME controller activity

➔ Power Button Mode [On/Off]

The **Power Button Mode** BIOS specifies how the power button functions.

→	On/Off	DEFAULT	When the power button is pressed the system is either
			turned on or off
→	Suspend		When the power button is pressed the system goes into
			suspend mode





6.8 Exit

The **Exit** menu (**BIOS Menu 21**) loads default BIOS values, optimal failsafe values and to save configuration changes.

	DIOS SI	IUP UIILIII		
Main Advanced PCIPnP	Boot	Security	Ch	ipset Power <mark>Exit</mark>
Exit Options				Exit system setup after saving the
Save Changes and Exit Discard Changes and Exit				changes.
Discard Changes				F10 key can be used for this operation.
Load Failsafe Defaults				
				 ← Select Screen ↑↓ Select Item Enter Go to Sub Screen F1 General Help F10 Save and Exit
u02 59 (C).Comunica	bt 1985-2	1005 Amorica	n Mer	ESC Exit

BIOS Menu 21:Exit

→ Save Changes and Exit

If configuration changes are complete, select this option to save them and exit the BIOS menus.

→ Discard Changes and Exit

If configuration changes are complete but do need to be saved, select this option to exit the BIOS menus.

➔ Discard Changes

Page 126

If configuration changes are complete but do need to be saved but BIOS still needs to be run, select this option.

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→ Load Optimal Defaults

This option loads optimal default values for each of the parameters on the Setup menus. **F9 key can be used for this operation.**

→ Load Failsafe Defaults

This option loads failsafe default values for each of the parameters on the Setup menus. **F8 key can be used for this operation.**





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Software Drivers





7.1 Available Software Drivers



The contents of the CD may vary throughout the life cycle of the product and is subject to change without prior notice. Visit the IEI website or contact technical support for the latest updates.

The WAFER-8522 board has five software drivers:

- Chipset
- Audio
- LAN
- VGA

All five drivers can be found on the CD that came with the WAFER-8522. To install the drivers please follow the instructions in the sections below

7.2 Chipset Driver Installation

Page 130

To install the chipset driver, please follow the steps below:

- Step 1: Insert the CD into the system that contains the WAFER-8522 board. Open the Chipset/852GM directory and locate the icon for the Setup installation file. Once located, use the mouse to double click the icon.
- Step 2: The "InstallShield Wizard Preparation Screen" in Figure 7-1 appears.




Figure 7-1: InstallShield Wizard Preparation Screen

Step 4: The "Welcome" window in Figure 7-2 appears next.

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Figure 7-2: Welcome Screen

Step 5: Click "Next" and the license agreement shown in Figure 7-3 appears.



Figure 7-3: License Agreement

Step 6: Agree to the license terms by clicking "Yes". The "Readme" in Figure 7-4

appears.



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Setup		x
Readme Information		
Readme.txt		**************************************
 * Product: Intel(R) Chipset Software Instal * Release: Production Version * Version: 6.0.1.1002 * Target Chipset#: Intel(R) E7520 & Intel(F * Date: May 07, 2004 	R) 915G/P/GV	4
NOTE: For the list of supported chipsets, p the Release Notes	Wease refer to	
nstallShield		P
	< <u>B</u> ack Nex	t> Cancel

Figure 7-4: Readme Information

Step 7: Click "Yes". The driver is installed on the computer. After the installation is complete, the installation complete screen shown in Figure 7-5 appears. Select the preferred option and click "Finish" to complete the installation process.



Figure 7-5: Restart the Computer

Page 132

7.3 RealTek Audio Driver Installation

To install the RealTek AC'97 Audio driver, please follow the steps below:

Step 1: Insert the CD into the system that contains the WAFER-8522 board. Open the CD folder and locate the AUDIO DRIVER A3.79 directory. Open the directory and look for icon for the setup.exe installation file. Once located, use the mouse to double click the icon.

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Step 2: Once double clicking the Setup icon, the install shield wizard for the audio driver starts. See Figure 7-6.



Figure 7-6: Audio Driver Install Shield Wizard Starting

Step 3: The RealTek Audio Setup prepares the install shield to guide through the rest of the setup process. See Figure 7-7.





Step 4: After install shield is prepared, the welcome screen shown in Figure 7-8





appears. To continue the installation process, click the "**Next**" button. The install shield starts to configure the new software as shown in **Figure 7-9**.



Figure 7-8: Audio Driver Welcome Screen





Step 5: At this stage the "Digital Signal Not Found" screen shown in Figure 7-10 appears. To continue the installation process, click the "Yes" button. The installation notice shown below appears.





Figure 7-10: Audio Driver Digital Signal

Step 6: At this stage the clicking the "Yes" button in Figure 7-10 appears, the installation of the driver begins. See Figure 7-11.

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Figure 7-11: Audio Driver Installation Begins

Step 7: After the driver installation process is complete, a confirmation screen shown inFigure 7-12 appears







Figure 7-12: Audio Driver Installation Complete

Step 8: The confirmation screen shown in Figure 7-12 allows user to restart the computer immediately after the installation is complete or to restart the computer later. For the settings to take effect the computer must be restarted. Once decided when to restart the computer, click the "Finish" button.

7.4 Intel Graphics Media Accelerator Driver

To install the GMA driver, please follow the steps below:

- Step 1: Insert the CD into the system that contains the WAFER-8522. Open the CD folder and locate the icon for the Setup installation file. Once located, use the mouse to double click the icon.
- **Step 2:** Once double clicking the Setup icon, a Welcome screen shown in **Figure 7-13** appears.



Intel(R) Graphics Med	ia Accelerator Driver		
int _e l.	Welcome to the setup for the Intel[R] Graphics Media Accelerator Driver.		
	This program will install the Intel(R) Graphics Media Accelerator Driver on this computer. It is strongly recommended that you exit all Windows programs before continuing.		
	<back next=""> Cancel Intell'B1Instalation Frameworks</back>		

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Figure 7-13: GMA Driver Installation Welcome Screen

Step 3: To continue installing click "Next" and a license agreement shown in Figure

7-14 appears. Read through the license agreement.



Figure 7-14: GMA Driver License Agreement

Step 4: Accept the terms and conditions stipulated in the license agreement by clicking the "Yes" button (Figure 7-14). The installation notice shown in Figure 7-15 appears.





Installing version 6.14.10.4497....



Step 5: After the driver installation process is complete, a confirmation screen shown in

Figure 7-16 appears.

Accelerator Driver is complete.
You must restart this computer for the changes to take effect. Would you like to restart the computer now?
 Yes, I want to restart my computer now, No, I will restart my computer later.
Remove any disks from their drives, and then click Finish.
< Book Einish

Figure 7-16: GMA Driver Installation Complete

Step 6: The confirmation screen shown in Figure 7-16 allows user to restart the computer immediately after the installation is complete or to restart the computer later. For the settings to take effect the computer must be restarted. Once decided when to restart the computer, click the "Finish" button.

7.5 LAN Driver Installation

Page 138

To install the LAN driver, please follow the steps below:

- Step 1: Insert the CD into the system that contains the WAFER-8522. Open the LAN directory and locate the icon for the relevant Setup installation file. Once located, use the mouse to double click the icon.
- Step 2: Once double clicked the Setup icon, a LAN License Agreement screen shown inFigure 7-17 appears.

License Agreement		
Please read the following I	license agreement carefully.	
INTEL SO	FTWARE LICENSE AGREEMENT	
HIRAPTINT PEIR		
IMPORIANT - REAUT	REFORE COPYING, INSTALLING	OR HSING.
IMPORTANT - READ I Do not use or load this	BEFORE COPYING, INSTALLING software and any associated ma	<u>OR USING</u> . Iterials
IMPORTANT - READ Do not use or load this (collectively, the "Softw following terms and co	<u>BEFORE COPYING, INSTALLING</u> software and any associated ma vare") until you have carefully re nditions. By loading or using the	<u>OR USING</u> . Iterials ead the e Software,
IMPORIANT - READ I Do not use or load this (collectively, the "Softw following terms and co you agree to the terms agree, do not install or	BEFORE COPYING, INSTALLING software and any associated ma vare") until you have carefully re nditions. By loading or using the of this Agreement. If you do not use the Software.	<u>OR USING</u> . Interials and the Software, wish to so
IMPORIANT - READ Do not use or load this (collectively, the "Softw following terms and co you agree to the terms agree, do not install or	BEFORE COPYING, INSTALLING software and any associated ma vare") until you have carefully re nditions. By loading or using the of this Agreement. If you do not use the Software.	OR USING. Interials and the Software, wish to so
IMPORIANT - READ Do not use or load this (collectively, the "Softw following terms and co you agree to the terms agree, do not install or C 1 accept the terms in the lice	BEFORE COPYING, INSTALLING software and any associated ma vare") until you have carefully re nditions. By loading or using the of this Agreement. If you do not use the Software.	OR USING. iterials ead the 9 Software, wish to so •
IMPORIANT - READ Do not use or load this (collectively, the "Softw following terms and co you agree to the terms agree, do not install or I accept the terms in the lic I go not accept the terms in	BEFORE COPYING, INSTALLING software and any associated ma vare") until you have carefully re nditions. By loading or using the of this Agreement. If you do not use the Software. ense agreement the license agreement	OR USING. iterials aad the Software, wish to so vish to so
IMPORIANT - READ Do not use or load this (collectively, the "Softw following terms and co you agree to the terms agree, do not install or C I accept the terms in the lice C I accept the terms in alsheld	BEFORE COPYING, INSTALLING software and any associated ma vare") until you have carefully re nditions. By loading or using the of this Agreement. If you do not use the Software. ense agreement the license agreement	OR USING. Interials and the a Software, wish to so v

Figure 7-17: LAN License Agreement

Step 3: Accept the License Agreement by clicking "Next." The follow-up window

prompts for the directory the driver is stored in. (See Figure 7-18)

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Location to Save Files		4
Where would you like to save your file	15?	
Please enter the folder where you war exist, it will be created for you. To co	nt these files saved. If th ntinue, click Next.	ne folder does not
Save files in folder:		
c:\IntelPRO		
		Change



Step 4: After selecting the directory the driver is installed in, click "Next." The screen inFigure 7-19 appears.







Figure 7-19: LAN Driver Configuration

Step 5: In Figure 7-19, there are three options.

- Install Base Driver \rightarrow Installs the base driver
- Make Driver Disk \rightarrow Copies the driver to disk
- View Release Notes → Opens word document of the release notes







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BIOS Options



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System Overview	
System Time [xx:xx:xx]	
System Date [xx/xx/xx]	
Execute Bit Disable [Enabled]	
OnBoard PCI IDE Controller [Both]	
Onboard PCI IDE Operate Mode [L	egacy Mode]91
Hard Disk Write Protect [Disabled]	91
IDE Detect Time Out (Sec) [35]	
ATA (PI) 80Pin Cable Detection [Ho	ost & Device]92
IDE Master and IDE Slave	
Auto-Detected Drive Parameters	94
Type [Auto]	
ZIP	
LS-120	
LBA/Large Mode [Auto]	
Block (Multi Sector Transfer) [Auto	96
PIO Mode [Auto]	
DMA Mode [Auto]	
 S.M.A.R.T [Auto]	

ATA (PI) 80Pin Cable Detection [Host & Device]92			
IDE Master and IDE Slave93			
Auto-Detected Drive Parameters94			
Type [Auto]	95		
ZIP	95		
LS-120	95		
LBA/Large Mode [Auto]	95		
Block (Multi Sector Transfer) [Auto]96			
PIO Mode [Auto]	96		
DMA Mode [Auto]97			
S.M.A.R.T [Auto]	97		
32Bit Data Transfer [Disabled]	97		
Serial Port1 Address [3F8/IRQ4]	98		
Serial Port1 Mode [Normal]	99		
Serial Port2 Address [2F8/IRQ3]	99		
Serial Port2 Mode [Normal]99			
Restore on AC Power Loss [Power On]99			
Serial Port3 Address [3E8]	100		
Serial Port3 IRQ [11]	100		
Serial Port4 Address [2E8] 101			
Serial Port4 IRQ [10]	101		
Serial Port5 Address [2F0]	101		
Serial Port5 IRQ [11] 102			

Serial Port6 Address [2E0] 102			
Serial Port6 IRQ [10] 102			
MPS Revision [1.1] 105			
TPM Device [Disabled] 106			
USB Configuration 107			
USB Devices Enabled			
USB Function [4 USB Ports] 107			
Legacy USB Support [Enabled]108			
USB 2.0 Controller [Enabled] 108			
USB2.0 Controller Mode [FullSpeed]108			
Device ##			
Emulation Type [Auto] 109			
Quick Boot [Enabled] 112			
Quiet Boot [Disabled] 112			
Boot Display Device [Auto] 113			
Spread Spectrum Mode [Disabled] 113			
Change Supervisor Password 116			
Change User Password 116			
Clear User Password			
DRAM Frequency [Auto] 118			
Configure DRAM Timing by SPD [Enabled] 118			
Memory Hole [Disabled]119			
Init. Graphic Adapter Priority [PCI/Int-VGA] 119			
Internal Graphics Mode Select [Enable, 8MB] 120			
Graphics Aperture Size [64MB] 120			
Boot Display Device [Auto] 120			
Flat Panel Type [1280x1024] 121			
Local Flat Panel Scaling [Auto] 121			
OnBoard AC97 Audio [Auto] 123			
OnBoard Lan Rom [Disabled] 123			
Power Type Select [AT] 124			



Page 143

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Resume on Ring [Disabled]	125
Resume on PME# [Enabled]	125
Power Button Mode [On/Off]	125
Save Changes and Exit	126
Discard Changes and Exit	126
Discard Changes	126
Load Optimal Defaults	127
Load Failsafe Defaults	127





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Watchdog Timer







The following discussion applies to DOS environment. IEI support is contacted or the IEI website visited for specific drivers for more sophisticated operating systems, e.g., Windows and Linux.

The Watchdog Timer is provided to ensure that standalone systems can always recover from catastrophic conditions that cause the CPU to crash. This condition may have occurred by external EMI or a software bug. When the CPU stops working correctly, Watchdog Timer either performs a hardware reset (cold boot) or a Non-Maskable Interrupt (NMI) to bring the system back to a known state.

A BIOS function call (INT 15H) is used to control the Watchdog Timer:

AH – 6FH Sub-function:		
AL – 2:	Sets the Watchdog Timer's period.	
BL:	Time-out value (Its unit-second is dependent on the item "Watchdog	
	Timer unit select" in CMOS setup).	

INT 15H:

Table B-1: AH-6FH Sub-function

Call sub-function 2 to set the time-out period of Watchdog Timer first. If the time-out value is not zero, the Watchdog Timer starts counting down. While the timer value reaches zero, the system resets. To ensure that this reset condition does not occur, calling sub-function 2 must periodically refresh the Watchdog Timer. However, the Watchdog timer is disabled if the time-out value is set to zero.

A tolerance of at least 10% must be maintained to avoid unknown routines within the operating system (DOS), such as disk I/O that can be very time-consuming.





When exiting a program it is necessary to disable the Watchdog Timer, otherwise the system resets.

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Example program:

; INITIAL TIMER PERIOD COUNTER

W_LOOP:

;

;

;

MOV	AX, 6F02H	;setting the time-out value
MOV	BL, 30	;time-out value is 48 seconds
INT	15H	

; ADD THE APPLICATION PROGRAM HERE

CMP	EXIT_AP, 1	; is the application over?
JNE	W_LOOP	;No, restart the application
MOV	AX, 6F02H	; disable Watchdog Timer
MOV	BL, 0	;
INT	15H	

; **EXIT** ;

;





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Address Mapping



C.1 Address Map

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I/O address Range	Description
000-01F	DMA Controller
020-021	Interrupt Controller
040-043	System time
060-06F	Keyboard Controller
070-07F	System CMOS/Real time Clock
080-09F	DMA Controller
0A0-0A1	Interrupt Controller
0C0-0DF	DMA Controller
OFO-OFF	Numeric data processor
1FO-1F7	Primary IDE Channel
2E0-2E7	Serial Port 6 (COM6)
2E8-2EF	Serial Port 4 (COM4)
2F0-2F7	Serial Port 5 (COM5)
2F8-2FF	Serial Port 2 (COM2)
378-37F	Parallel Printer Port 1 (LPT1)
3B0-3BB	Intel Graphics Controller
3C0-3DF	Intel Graphics Controller
3E8-3EF	Serial Port 3 (COM3)
3F6-3F6	Primary IDE Channel
3F8-3FF	Serial Port 1 (COM1)

Table C-1: IO Address Map

C.2 1st MB Memory Address Map

Memory address	Description
00000-9FFFF	System memory
A0000-BFFFF	VGA buffer
F0000-FFFFF	System BIOS
100000-	Extend BIOS

Table C-2: 1st MB Memory Address Map

Page 150

C.3 IRQ Mapping Table

IRQO	System Timer	IRQ8	RTC clock
IRQ1	Keyboard	IRQ9	ACPI
IRQ2	Available	IRQ10	COM4/COM6
IRQ3	COM2	IRQ11	COM3/COM5
IRQ4	COM1	IRQ12	PS/2 mouse
IRQ5	SMBus Controller	IRQ13	FPU
IRQ6	FDC	IRQ14	Primary IDE
IRQ7	Available	IRQ15	Secondary IDE

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Table C-3: IRQ Mapping Table

C.4 DMA Channel Assignments

Channel	Function
0	Available
1	Available
3	Available
4	Cascade for DMA controller 1
5	Available
6	Available
7	Available

Table C-4: IRQ Mapping Table





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External AC'97 Audio CODEC







D.1 Introduction

The motherboard comes with an on-board Realtek ALC203 CODEC. Realtek ALC203 is a 16-bit, full duplex AC'97 Rev. 2.3 compatible audio CODECwith a sampling rate of 48KHz.

D.1.1 Accessing the AC'97 CODEC

The CODEC is accessed through a connector on the WAFER-8522 motherboard. Connect the audio kit to the connector.

D.1.2 Driver Installation

The driver installation has been described in Chapter 7

After rebooting the sound effect configuration utility appears in the Windows Control Panel (see **Figure D-1**). If the peripheral speakers are properly connected, sound effects should be heard.





D.2 Sound Effect Configuration

D.2.1 Accessing the Sound Effects Manager



To access the Sound Effects Manager, please do the following:

Step 6: Install the audio CODEC driver.

Step 7: Click either:

 The Sound Effect Manager icon in the Notification Area of the system task bar (see Figure D-2), or

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The Sound Effect Manager icon in the Control Panel (Figure D-3).



Figure D-2: Sound Effect Manager Icon [Task Bar]



Figure D-3: Sound Effect Manager Icon [Control Panel]

Step 8: The sound effect manager appears.





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The Sound Effect Manager shown above is for the RealTek ALC655 audio CODEC. Different CODECs may have different sound manager appearances.

The following section describes the different configuration options in the Sound Effect Manager.

D.2.2 Sound Effect Manager Configuration Options

The **Sound Effects Manager** enables configuration of the items listed below. To configure these items click the corresponding menu tab in the **Sound Effects Manager**.



The **Karaoke Mode** is configured in the **Sound Effect** menu. To access Karaoke configuration settings, click on the **Sound Effect** menu tab.

- Sound Effect
- Karaoke Mode
- Equalizer
- Speaker Configuration
- Speaker Test
- S/PDIF-In
- S/PDIF-Out
- Connector Sensing
- HRTF Demo
- Microphone Effect
- General

Page 156



Not all RealTek **Sound Effect Managers** have all the above listed options. The Sound Effect Manager loaded onto the system may only have some of the options listed above.

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Below is a brief description of the available configuration options in the **Sound Effects Manager**.

- Sound Effect:- Select a sound effect from the 23 listed options in the drop down menu. Selected sound effect properties can be edited. To edit the sound effect click "EDIT."
- Karaoke Mode:- The Karaoke Mode is accessed in the Sound Effect window. The Voice Cancellation disables the vocal part of the music being played. The Key adjustment up or down arrow icons enables users to define a key that fits a certain vocal range.
- Equalizer Selection: Preset equalizer settings enable easy audio range settings. Ten frequency bands can be configured.
- Speaker Configuration:- Multi-channel speaker settings are configured in this menu. Configurable options include:
 - O Headphone
 - O Channel mode for stereo speaker output
 - O Channel mode for 4 speaker output
 - O Channel mode for 5.1 speaker output
 - O Synchronize the phonejack switch with speakers settings
- Speaker Test:- Each speaker connected to the system is tested individually to see if the 4-channel or 6-channel audio operates properly.
- S/PDIF-In & S/PDIF-Out.- These functions are currently not supported.



 Connector Sensing:- Realtek ALC655 detects if an audio device is plugged into the wrong connector. If an incorrect device is plugged in a warning message appears.

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- HRTF Demo:- Adjust HRTF (Head Related Transfer Functions) 3D positional audio here before running 3D applications.
- *Microphone Effect*:- Microphone noise suppression is enabled in this menu.
- General:- General information about the installed AC'97 audio configuration utility is listed here.







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1 10/100 Mbps Ethernet16 8

®Technology Corp.

852GM16,	129

А

airflow7
ALC655 CODEC1
anti-static precautions30, 6
anti-static pad30, 6
anti-static wristband30, 6
handling30, 6
self-grounding30, 6
Application Accelerator10
AT power connector
location and pinouts30
ATA9
ATA flat cable70
ATX power connector
location and pinouts3
audio
connector7
Audio 129, 132, 133, 134, 135
audio connector
location and pinouts38
audio kit7
Audio Kit7
Audio kit cable7

В

BIOS 24, 83, 84, 85, 86, 87, 88, 89, 90, 92,
93, 97, 103, 104, 105, 106, 108, 110, 112,
113, 114, 115, 116, 117, 122, 123, 125,
126
BIOS chipset 24

С

cables	75
Celeron	3, 15
CF card	. 39, 65, 69
CF card setup jumper	69
installation	65
location and pinouts	
socket	
CF card setup jumper	69
location	69
chassis	75
installation	75
chipset driver	129
Clear CMOS	6
clear CMOS jumper	70
location	70
settings	70
CMOS	70
clear CMOS jumper	70
COM 3	51
connector location and pinouts.	51
RS-232	51
COM 4	51
connector location and pinouts.	51
RS-232	51

Page 160

®Technology Corp.

COM 551
connector location and pinouts51
RS-23251
COM 651
connector location and pinouts51
RS-23251
COM port setting jumper71
location71
settings71
CompactFlash39
socket location and pinouts
connectors, external
RJ-45 Ethernet connector56
Serial Port connector57
USB port58
VGA58
connectors, pinouts and location
AT power36
ATX power37
audio38
COM 3 serial port51
COM 4 serial port51
COM 5 serial port51
COM 6 serial port51
CompactFlash39
IDE40
inverter42
Keyboard/Mouse43
LED44
PCI-104 slot45
power button49
reset button49
RS-23251
RS-422/485/48550
TFT LCD LVDS (20-pin)53

WAFER-8522 Motherboard

USB	54
cooling	75
airflow	75
CRT	17, 112, 119, 120

D

dimensions11
board11
enclosure heat sink12
external peripheral interface connector
panel12
Dual-independent display4
Dynamic Video Memory Technology v2.016

Е

electrostatic discharge 30, 61
enclosure heat sink 3, 12
Enhanced Intelligent Memory Management
16
Enhanced Rapid Pixel and Texel Rendering
16
Ethernet 16, 56, 80
RJ-45 cable connector80
RJ-45 connector56
external peripheral interface80
connection80
connectors80

fanless	3
form factor, 3.5	4
FSB	88

F

	G		

gigabit Ethernet	4
Graphics Media Accelerator	135

Н

HDD	44
activity	44
indicator LED	44

I

ICH4xv, 7, 18, 19, 20, 21, 22, 24, 122
IDE connector, 44-pin41
location and pinouts41
IDE device76
ATA flat cable76
connector76
installation checklist63
Intel® 852GM7
Intel® Extreme Graphics 215, 16
Intel® Streaming SIMD Extensions15
IrDA

J

jumper	68
CF card setup	69
clear CMOS	70
COM port setting	71
jumper configuration	68
jumper settings	68
LCD resolution	73
LCD voltage selection	72

Κ

®Technology Corp.

keyboard controller	25
keyboard/mouse	78
cable connection	78
onboard connector	78
Y-cable	78
keyboard/mouse	43
keyboard/mouse connector	43
keyboard/mouse. connector	
location and pinouts	43

L

LAN 16, 129	, 137, 138
LAN manageability	16
LCD display	72, 73
LCD resolution	73
voltage select	72
LCD resolution jumper	73
settings	73
LCD rotation jumper	
location	74
LCD Voltage	6
LCD voltage selection jumper	72
location	73
settings	72
LED	
HDD indicator	44
power status	44
LED connector	44
HDD indicator LED connector	44
location and pinouts	44
power LED connector	44
LEDs	57



®Technology Corp.

LPC bus	24
LPC interface	21
LVDS	17

Μ

memory module	16
memory module installation	64
motherboard	75
installation	75

Ν

NetBurst® micro-architecture15

Ρ

PCI bus22	2
PCI interface2	1
PCI-104 3, 4, 6, 7, 22, 23, 35, 45, 48, 49	9
PCI-104 slot48	5
location and pinouts4	5
peripheral connectors	ô
peripheral device cables75	5
power button connector49	9
location and pinouts4	9
Power Button Mode124	4
power consumption27	7
power supply36, 37	7
AT power supply36	ô
ATX power supply37	7
power LED44	4
processors15	5
PS/2 cable43	3

R

REALTEK ALC655 CODEC	.19
RealTek Audio Driver 1	32
reset button connector	.50
location and pinouts	.50
RJ-45 6,	57
RJ-45 Ethernet connector 55, 56,	57
pinouts	.56
RoHS compliant	4
RS-232	71
COM 1 location and pinouts	.57
connector location and pinouts	.57
RS-4227, 35, 50, 51,	71
RS-4857, 50,	71

S

serial port	
cable connection	79
four serial port conne	ector cable79
onboard connector	79
Serial port	. 6, 99, 100, 101, 102
Serial Port	. 97, 98, 99, 100, 101
serial port connector	51, 57
location and pinouts.	51, 57
serial port devices	80
six-channel audio COD	EC19
SO-DIMM	64
installation	64
specifcations	64
software drivers	129
srial communications po	ort55
Super I/O chipset	24
system voltages	103

Page 4

Т

technical specifications	7
temperature	103
TFT LCD LVDS connector, 20-pin	53
location and pinouts	53

U

USB combo port	55
USB host controllers	15

V

®Technology Corp.

VGA	59, 118, 119
connector	55
connector pinouts	59
DB15 connector	59
monitor	80
VGA connector	6

W	
WAFER-8522	129, 132
warranty validation	63

Ζ

Zone Rendering 2 Technology......16

